

subminiature USB2.0 camera series



subminiature USB3.1 Gen 1 camera series



## 1. Introduction

### 1.1. About This Manual

Dear customer,

Thank you for purchasing a product from XIMEA.

We hope that this manual can answer your questions, but should you have any further questions or if you wish to claim a service or warranty case, please contact your local dealer or refer to the XIMEA Support on our website:

#### www.ximea.com/support

The purpose of this document is to provide a description of the XIMEA xiMU-Series cameras and to describe the correct way to install related software and drivers and run it successfully. Please read this manual thoroughly before operating your new camera for the first time. Please follow all instructions and observe the warnings.

This document is subject to change without notice.

#### 1.2. About XIMEA

XIMEA is one of the worldwide leaders for innovative camera solutions with a 25-year history of research, development and production of digital image acquisition systems. Based in Slovakia, Germany and the US and with a global distributor network, XIMEA offers their cameras worldwide. In close collaboration with customers XIMEA has developed a broad spectrum of technologies and cutting-edge, highly competitive products.

XIMEA's camera centric technology portfolio comprises a broad spectrum of digital technologies, from data interfaces such as USB 2.0, USB 3.1 and PCle to cooled digital cameras with CCD, CMOS and sCMOS sensors, as well as X-ray cameras.

XIMEA has three divisions – generic machine vision and integrated vision systems, scientific imaging and OEM/custom.

XIMEA cameras find use in many industrial applications, such as motion control, robotics, or quality control in manufacturing. The broad spectrum of cameras also includes thermally stabilized X-ray cameras, and specialty cameras for medical applications, research, surveillance and defense.

#### 1.2.1. Contact XIMEA

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Support https://www.ximea.com/support/wiki/allprod/Contact\_Support

xiMU - Technical Manual Version 2.10

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## 1.3. Standard Conformity

The xiMU cameras MU9Px-MH have been tested using the following equipment:

- MU-MINIUSB-Adapter
- A shielded USB 2.0 cable (1.5m)

The xiMU cameras MU181CR-ON have been tested using the following equipment:

- ADPT-MU-TC-V
- A shielded USB 3.0 cable (3.0m)

**Warning**: Changes or modifications to this unit not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment.

XIMEA recommends to use the same configuration to ensure the compliance with the following standards:

## 1.3.1. CE Conformity



The xiMU MU9Px-MH and MU181CR-ON cameras described in this manual comply with the requirements of the

EC EMC Directive 2014/30/EU electromagnetic compatibility of equipment

## 1.3.2. For customers in the US: FCC Conformity



The xiMU MU9Px-MH and MU181CR-ON cameras described in this manual have been tested and found to comply with Part 15 of the FCC rules, which states that:

Operation is subject to the following two conditions:

- · This device may not cause harmful interference, and
- This device must accept any interference received, including interference that may cause undesired operation.

This equipment has been tested and found to comply with the limits for Class A digital device, pursuant to part 15 of the FCC rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the users will be required to correct the interference at their own expense.

You are cautioned that any changes or modifications not expressly approved in this manual could void your authority to operate this equipment under above jurisdictions. The shielded interface cable recommended in this manual must be used with this equipment in order to comply with the limits for a computing device pursuant to Subpart J of Part 15 of FCC Rules.

#### 1.3.3. For customers in Canada

The xiMU MU9Px-MH and MU181CR-ON cameras comply with the Class A limit s for radio noise emissions set out in Radio Interference Regulations.

### 1.3.4. RoHS Conformity



The xiMU cameras comply with the requirements of the RoHS (Restriction of Hazardous Substances) Directive 2011/65/EU.



## 1.3.5. WEEE Conformity



The xiMU cameras comply with the requirements of the WEEE (waste electrical and electronic equipment) Directive 2012/19/EU.

#### 1.3.6. GenlCam GenTL API



GenlCam standard transport layer interface, grabbing images. GenlCam/GenTL provides an agnostic transport layer interface to acquire images or other data and to communicate with a device. Each XIMEA camera can be GenTL Producer.

## 1.4. Helpful Links

XIMEAHomepage http://www.ximea.com/

xiAPI stable versions download https://www.ximea.com/support/documents/4
 xiAPI beta versions download https://www.ximea.com/support/documents/14

Frequently Asked Questions
 http://www.ximea.com/support/wiki/allprod/Frequently\_Asked\_Questions

Knowledge Base http://www.ximea.com/support/wiki/allprod/Knowledge\_Base
 Vision Libraries http://www.ximea.com/support/projects/vision-libraries/wiki

XIMEA Registration http://www.ximea.com/en/products/register

XIMEA Live Support
 http://www.ximea.com/support/wiki/allprod/XIMEA\_Live\_Support

XIMEA General Terms & Conditions http://www.ximea.com/en/corporate/generaltc

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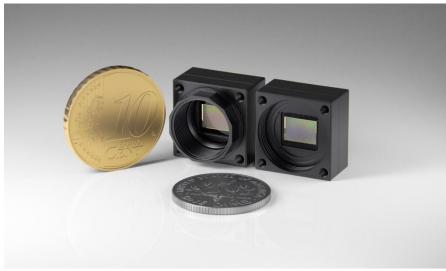
7.

6.



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# 2. xiMU USB2.0 and USB3.1 Gen 1 Camera Series





## 2.1. What is xiMU

xiMU [ksi-mju: or sai-mju:] is a subminiature USB Industrial camera family with outstanding features:

- Incredibly small: World smallest USB 2.0 and USB3.1 Gen 1 cameras with GenlCam/GenTL support.
- Low power consumption
- triggerable, fully industrial grade
- sensors: OnSemi 5MPixel MT9P031and ONSEMI 18MPixel AR1820HS.
- frame rates: up to 4.6 frames/sec for USB2.0 version and 21.9 frames/sec for USB3.1 Gen 1 version. Multiple binning and skipping modes with higher frame rates.



# 2.2. Advantages

smallest	fits into places where no other camera can fit
Robust	full metal housing, no sheet metal covers
Lightweight	facilitates increased performance of robotic arms and handheld devices
Connectivity	Programmable input and output
Compatibility	support for Windows, Linux and MacOS, various Image Processing Libraries
Software interfaces	GenlCam / GenTL and highly optimized xiAPI SDK
Economical	excellent value and price, low TCO and fast ROI
Images	Excellent image quality and low light sensitivity

table 2-1, advantages

# 2.3. Camera Applications

- 3D dental applications
- Miniature and fast robotic arms
- Mobile devices
- In-situ and endoscopic inspection camera
- Ophthalmology and Retinal imaging

# 2.4. Common features

Sensor Technology	CMOS, rolling shutter with Global Reset Release				
Acquisition Modes	Continuous, software trigger, hardware trigger				
Partial Image Readout	ROI, Skipping and Binning modes supported				
Image data formats	8, 10 or 12 bit RAW pixel data				
Color image processing	Host based de-Bayering, sharpening, Gamma, color matrix, true color CMS				
Hot/blemish pixels correction	On camera storage of 5000+ pixel coordinates, host assisted correction				
Auto adjustments	Auto white balance, auto gain, auto exposure				
Flat field corrections	Host assisted pixel level shading and lens corrections				
Image Data and Control Interface	USB2.0 model: Micro connector with USB 2.0 High-speed and digital I/O USB3.1 Gen 1 model: Various connectors with USB 3.0 Super-speed and digital I/O				
General Purpose I/O	4x IO configurable as input or output				
Synchronization	Hardware trigger input, software trigger, exposure active, frame active, trigger ready, exposure active pulse, busy				
Housing and lens mount	Standard S-mount (M12). Two lens mount adapters available				
Power requirements	USB2.0 model: Typ. 0.76 W, supplied via USB 2.0 interface USB3.1 Gen 1 model: Typ. 1.4W, supplied via USB 3.0 interface				
Environment	Operating 0°C to 50°C on housing, RH 80% non-condensing, -30°C to 70°C storage Ingress Protection: IP40				
Operating systems	Windows 10 (x86 and x64), Windows 7 SP1 (x86 and x64), Linux Ubuntu, MacOS 10.8 and newer				
Software support	xiAPI SDK, adapters and drivers for various image processing packages				
USB standard compatible	USB 2.0, Universal Serial Bus Specification Revision 2.0, April 27, 2000 USB 3.0, Universal Serial Bus 3.1 Specification Revision 1.0, July, 2013				

table 2-2, common features

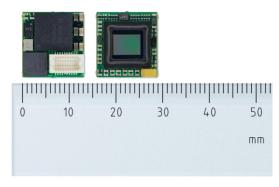
## 2.5. Models Overview

## 2.5.1. USB2.0 models

Model		Resolution	Pixel size	ADC [bit]	DR	Optical size	Sensor diagonal	FPS
MU9PM-MH	b/w	2502 v 1044	O O um	10	EO AD	1 / O E"	7.1 mm	4.46
MU9PC-MH	Color	2592 x 1944	2.2 μm	12	59 dB	1 / 2.5"	7.1 mm	4.46

table 2-3, USB2.0 model overview

USB2.0 models available in board level version as well



Order numbers name conventions for the different models:

Camera with housing:

MU9Px-MH

x: x=C: color model

x=M: black & white model

Board level camera:

MU9Px-MBRD

x: x=C: color model

x=M: black & white model

## 2.5.2. USB3.1 Gen 1 models

Model		Resolution	Pixel size	ADC [bit]	DR	Optical size	Sensor diagonal	FPS
MU181CR-ON	Color	4896 × 3680	1.25 μm	12	57.6 dB	1 / 2.3"	7.6 mm	21.9

table 2-4, USB3.1 Gen 1 model overview

Order numbers name conventions for the different models:

Camera with housing:

MU181CR-ON (for OEM projects)

MU181CR-ON-TC with mounted Type-C adapter

MU181CR-ON-FL with mounted -FL adapter

# 2.6. Accessories

The following accessories are available for the USB2.0 models:

Item P/N	Description
MU-MINIUSB	Mini-USB Extension Board for MU9Px-MH
ADPT-MU9P-USB2-UB-V	Expansion board with micro-B USB 2.0 connector and IO connector for MU9px-MH
CBL-MQSYNC-3M0	3.0m xiQ series I/O sync cable can be used with ADPT-MU9P-USB2-UB-V
ME-ADPT-MU-T-KIT	xiMU series tripod mounting bracket with Screws Kit

table 2-5, MU9 accessories

The following accessories are available for the USB3.1 Gen 1 models:

Item P/N	Description
ADPT-MU-TC-V	Type-C adapter with IO for xiMU USB3.1 Gen 1 cameras
ADPT-MU-FL	Flat-flex cable adapter for xiMU USB3.1 Gen 1 connecting from the bottom of the camera
ADPT-MU-FV	Flat-flex cable adapter for xiMU USB3.1 Gen 1 connecting perpendicular to sensor
CBL-MQSYNC-3M0	3.0m xiQ series I/O sync cable can be used with ADPT-MU-TC-V
CBL-MQ-FL-0M1	Cable FPC MQ/MC Flex-Line, 0.1m (gold color)
CBL-MQ-FL-0M25	Cable FPC MQ/MC Flex-Line, 0.25m (gold color)
CBL-USB3FLEX-0M10	Cable FPC MQ/MC Flex-Line, 0.1m (white color)
CBL-USB3FLEX-0M25	Cable FPC MQ/MC Flex-Line, 0.25m (white color)
CBL-USB3FLEX-0M50	Cable FPC MQ/MC Flex-Line, 0.5m (white color)
BOB-MQ-FL	Break Out Board, Flex-Line, Simple Board Level Micro-B USB3.0
ME-ADPT-MU-T-KIT	xiMU series tripod mounting bracket with Screws Kit

table 2-6, MU181 accessories



# 3. xiMU Hardware Specification

## 3.1. General Specification

#### 3.1.1. Environment

Description	Symbol	Value
Optimum ambient temperature operation	T <sub>opt</sub>	+10 to +25°C
Housing temperature operation	T <sub>max</sub>	0 - +50°C
Ambient temperature for storage and transportation	T <sub>storage</sub>	-30 - +70°C
Relative Humidity, non-condensing	RH	80 %

table 3-1, environment

Housing temperature must not exceed +65°C. The following parameters are not guaranteed if the camera is operated outside the optimum range:

- Dark current
- Dynamic Range
- Linearity
- Acquisition
- Readout noise
- S/N ratio
- Durability

Please refer to chapter 3.1.2 Heat dissipation

### 3.1.2. Heat dissipation

XIMEA strives to offer the smallest cameras with the highest performance. Although the cameras are first in terms of power efficiency, the high packing density of components can lead to elevated temperatures, and an adequate dissipation of this heat must be ensured. The cameras rely on adequate surface contact with a thermal mass (tripod, lens, heat sink) of sufficient size for heat dissipation and this must be provided ensured by the user.

#### 3.1.3. Firmware / Host driver / API features

Description	Value
Interpolation methods	9331, SHT advanced
White balance coefficients ranges	0.0 to 3.9
Sharpness filter	0 to 100 %
Gamma	0.3 to 1.0
Full color correction matrix (3+1)x3 coefficients ranges	-3.9 to 3.9

table 3-2, firmware / API features

More details on API/SDK features are available at XIMEA support pages: https://www.ximea.com/support/wiki/apis/APIs

### 3.1.4. Power Supply

The xiMU cameras are powered via the USB connector.

The input voltage is 5 V DC ( $\pm 10\%$ ). The typical power consumption is 0.76W for the USB2.0 version and 1.4W for the USB3.1 Gen 1 version.



# 3.1.5. Optical path

No additional filter glass.

# 3.2. xiMU USB2.0 specification

# 3.2.1. Sensor and camera parameters

xiMU model		MU9PC-MH	MU9PM-MH	
Sensor parameter				
Brand		Aptina, MT9P031I12STC	Aptina MT9P031I12STM	
Color filter		RGB Bayer mosaic	None	
Туре		Rolling shu	tter, Global Reset Release	
Pixel Resolution (H × V)	[pixel]		2592 × 1944	
Active area size (H $\times$ V)	[mm]		$5.7 \times 4.3$	
Sensor diagonal	[mm]		7.1	
Optical format	[inch]		1 / 2.5 (4:3)	
Pixel Size ( $H \times V$ )	[µm]		2.2 x 2.2	
ADC resolution	[bit]		12	
FWC	[ke-]		4.9	
Dynamic range	[dB]		59	
SNR Max	[dB]		37	
Conversion gain	[e-/LSB <sub>12</sub> ]		0.82	
Dark noise	[e-]		5	
DSNU	[e-]		0.92	
PRNU	[%]	2		
Linearity	Linearity [%]		<0.2	
Camera parameters				
Digitization	[bit]		12	
Supported bit resolutions	[pit/pixel]		8, 10, 12	
Exposure time (EXP) <sup>2</sup>		,	20µs 10sec	
Variable Gain Range (VGA)	[dB]		18	
Refresh rate (MRR) 1	[fps]		4.6	
Power consumption				
typical	[W]		0.76	
Maximum	[W]		0.9	
Idle	[W]		0.3	
Dimensions/Mass MU9Px-MH	(with housing)			
Height $\times$ width $\times$ depth	[mm]		$15 \times 15 \times 8.5$	
mass	[g]		ter) / 4.0 (with MECH-MU9-MH-ADAPT-M) / IECH-MU9-MH-ADAPT-L)	
Dimensions/Mass MU9Px-MBF	RD (board			
${\sf Height} \times {\sf width} \times {\sf depth}$	[mm]	$14 \times 13.2 \times 3.7$ (measured w/o connector) $14 \times 13.2 \times 5.5$ (measured with connector)		
mass	[g]	1.2		

table 3-3, MU9 sensor and camera parameters

#### Notes:

The figure indicates the maximum achievable frame rate for full frame readout. The real performance will be affected by USB controller, number and type of USB devices attached to this controller, system processor and memory speed and configuration.



2) Minimal exposure depends on readout mode and bandwidth limitation. For full resolution minimal exposure is  $110\mu s$ 

Binning/skipping	pixels	fps	Bit/px
1x1	2592 x 1944	4.6	12
2x2 bin	1296 x 972	14.3	12
4x4 bin	648 x 486	31.6	12
2x2 skip	1296 x 972	18.3	12
4x4 skip	648 x 486	71.9	12
6x6 skip	430 x 324	142	12
7x7 skip	368 x 376	172	12
7x7 skip/clip	320 x 240	200	12

table 3-4, MU9 readout modes (with compatible USB packet size – see 4.7.2 Packet Size Setting)

# 3.2.2. Quantum efficiency curves [%]

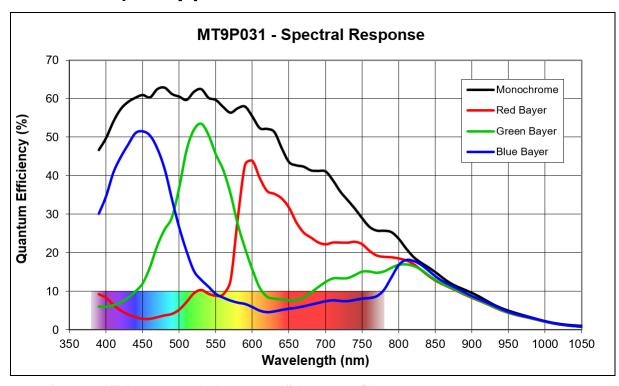


figure 3-1, MT9P031 mono and color, quantum efficiency curve, @Aptina



# 3.2.3. Dimensional drawings (without Lens Mount Adapter)

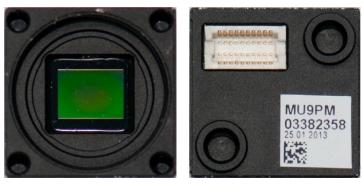


figure 3-2, MU9Px-MH, image front and rear side

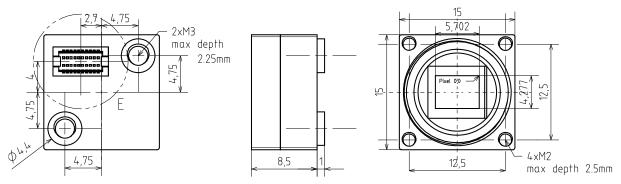


figure 3-3, MU9Px-MH, dimensional drawing

## 3.2.4. Referenced documents

- Aptina Datasheet MT9P031\_DS Rev. F 5/11 EN
- Aptina Outgoing Defect Specification, MT9P031\_0DS.fm Rev. A 9/07 EN

## 3.2.5. Camera features

feature	Note	
Binning	Yes: 2x2 and 4x4	
Skipping	Yes: 2x2, 4x4, 6x6, 7x7 and 7x7 skip/clip	
ROI	Yes, 4-pixel granularity	
HW Trigger	Trigger without overlap usable (see 4.3.2.3 Triggered mode)	
Image formats	RAW, (RGB24, RGB32 – only color models)	

table 3-5, MU9 sensor features



# 3.2.6. MU9 Lens Mount Adapters

There are two lens mount adapters available (S-Mount, M12 x 0.5 thread).

# 3.2.6.1. MECH-MU9-MH-ADAPT-M, dimensional drawing

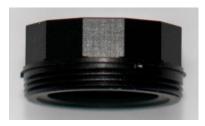


figure 3-4, lens mount adapter MECH-MU9-MH-ADAPT-M, image

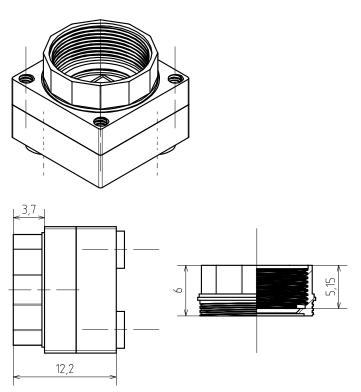


figure 3-5, lens mount adapter MECH-MU9-MH-ADAPT-M, drawing

Geometric Back-focal Distance (measured from the top of the flange to the top of the sensor die): 7.39 mm.

# 3.2.6.2. MECH-MU9-MH-ADAPT-L, dimensional drawing



figure 3-6, lens mount adapter MECH-MU9-MH-ADAPT-L image

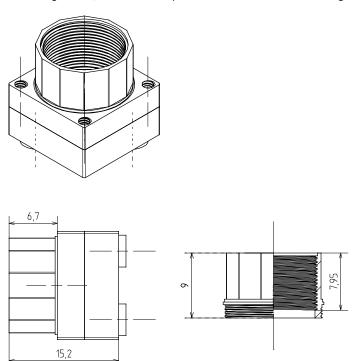


figure 3-7, lens mount adapter MECH-MU9-MH-ADAPT-L, drawing

Geometric Backfocal Distance (measured from the top of the flange to the top of the sensor die): 10.39 mm.

# 3.2.7. MU9 Camera connector (USB / IO Interface)



figure 3-8 MU9 camera connector

The connector mounted on the camera PCB is a

HRS DF12E(3.5)-20DP

## 3.2.7.1. Location and Pinout

The camera connector is located on the back side of the camera:

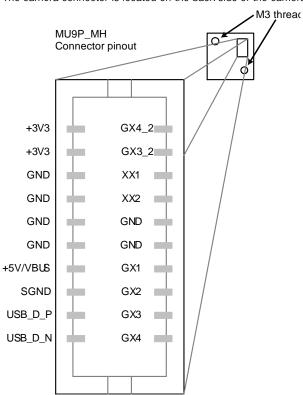


figure 3-9, MU9 camera connector, location and pin-out

## 3.2.7.2. Signal description

MU9 camera connector pin assignment and signal description:

Pin	Signal	Description	Electrical type	Function	
1	GX4	Programmable IO	10	defined by user, default setting: OFF	
2	USB_D_N	USB data -	10	USB data wire	
3	GX3	Programmable IO	10	defined by user, default setting: OFF	
4	USB_D_P	USB data +	10	USB data wire	
5	GX2	Programmable IO	10	defined by user, default setting: exposure active (XI_GPO_EXPOSURE_ACTIVE)	
6	SHLD	Camera Shield	Power	Chassis ground - Connected to GND via 1M/10nF	
7	GX1	Programmable IO	10	defined by user, default setting: trigger input (XI_GPI_TRIGGER)	
8	+5V	USB bus Power	Power	Camera Power supply	
9	GND	Ground	Power	Signal Ground	
10	GND	Ground	Power	Signal Ground	
11	GND	Ground	Power	Signal Ground	
12	GND	Ground	Power	Signal Ground	
13	XX2	Do not use	10	defined by firmware, do not connect	
14	GND	Ground	Power	Signal Ground	
15	XX1	Do not use	10	defined by firmware, do not connect	
16	GND	Ground	Power	Signal Ground	
17	GX3_2	Programmable IO	10	Shared functionality with GX3, only one could be connected	
18	+3V3	Internal power rail +3V	Power	No external connection allowed, used for testing purposes only	
19	GX4_2	Programmable IO	10	Shared functionality with GX4, only one could be connected.	
20	+3V3	Internal power rail +3V	Power	No external connection allowed, used for testing purposes only	

table 3-6, MU9 camera connector, signal description

#### Notes:

- None of the pins is galvanically isolated
- The IO pins are connected to the FPGA via 1K serial resistor

#### 3.2.7.2.1.

GX1 and GX2 are ESD protected

## 3.2.7.2.2. Ground

This signal connected to the internal signal ground

### 3.2.7.2.3. +3V

Connected internally to the camera +3V power supply. Used only for testing purposes. This pin must be left open and no load can be connected to it.

## GX1, GX2, GX3, GX4, GX3\_2, GX4\_2 - Programmable IO

These pins are connected to the FPGA pins via serial resistors of  $1K\Omega$ . GX1 and GX2 are ESD protected. GX3 and GX4 are NOT ESD protected.

Functionality of these pins is defined by firmware. Generic camera firmware puts pins into high impedance state.

All output functions have inverted polarity.



# 3.2.7.3. GXn DC electrical characteristics

Parameter		Symbol	Min	Nom	Max
Input voltage that indicates a Low logic level	[V]	VIL	-	-	0.8
Input voltage that indicates a High logic level	[V]	VIH	2.0	1	1
Input leakage current	[µA]	<b>I</b> L	-10	1	+700
Input voltage extremes to avoid turning on I/O protection diodes	[V]	Vin	-0.5	1	3.8
Output voltage that indicates a Low logic level	[V]	Vol			0.4
Output voltage that indicates a High logic level	[V]	Vон	2.9		
Output current condition under which VoL is tested	[mA]	lol		0.4	
Output current condition under which VoH is tested	[mA]	Іон		-1.0	

table 3-7, MU9 IO ports GXn, electrical characteristics



### 3.2.8. MU9 Patch cable

MU USB 2.0 Patch Cable 1.0m

The camera side connector of the cable is DF12C-20DS which is mounted on a special jumper board, from which a split flat-ribbon cable is wired to a standard USB Series "A" connector (J2) and a trigger connector (J3) Molex PN: 0510210600 Female Housing.

Recommended mating part for trigger connection are Molex PNs: 0532610671 or 0510470600 or 0530470610 or 0533980671.



figure 3-10, MU9 Patch cable

## 3.2.8.1. Signal Description (USB 2.0 connector)

Pin	Signal	Description
1	+5V	USB bus Power
2	USB-	USB data -
3	USB+	USB data +
4	GND	Ground

table 3-8, patch cable USB 2.0 connector, signal description

### 3.2.8.2. Signal Description (IO connector)

Pin	Signal	Description
1	GX2	Programmable IO
2	GX1	Programmable IO
3	GND	Ground
4	GX3_2	Programmable IO parallel function with GX3
5	GX4_2	Programmable IO parallel function with GX4

table 3-9, patch cable IO connector, signal description

For details please see 3.2.7.2 Signal description

### 3.2.8.3. Connection of patch cable

Note: The cable must always be inserted in the orientation shown below!!

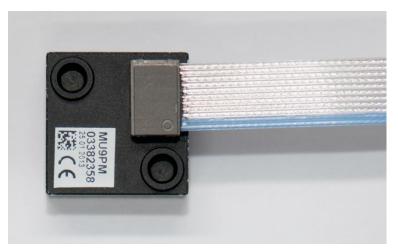


figure 3-11, connection of patch cable

## 3.2.9. MU-MINIUSB



figure 3-12, MU-MINIUSB, image connector and camera side

The Mini-USB Extension Board for MU9Px-MH provides

- standard Mini-USB connector
- IO connector with all four digital IO-ports. Dual row female socket connector, 2MM 10POS, NPPN052FFKP-RC

Weight (with screws): 2.9 g (please see 3.2.16 Scope of delivery MU-MINIUSB)

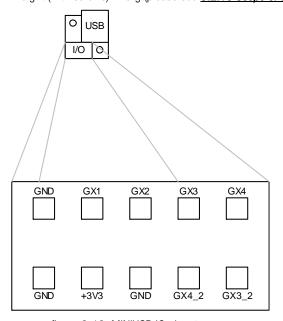


figure 3-13, MINIUSB IO pinout

# Mini B-Type USB Interface

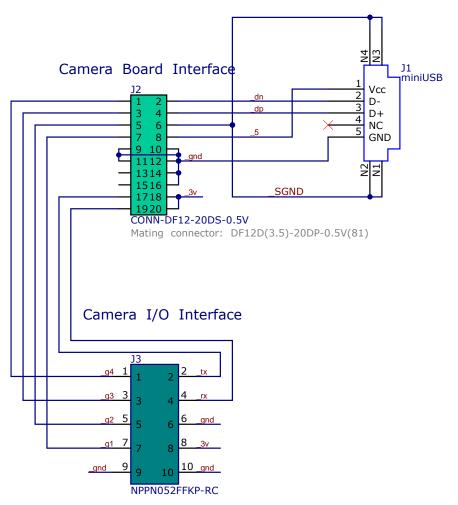


figure 3-14, MINIUSB connection diagram

For details about the signal description please see <u>3.2.7.2 Signal description</u>.

## 3.2.10. ADPT-MU9P-USB2-UB-V

This adapter provides standard microB USB 2.0 connector and IO connector (SR38) for connection to GX1 and GX2 GPIO ports..

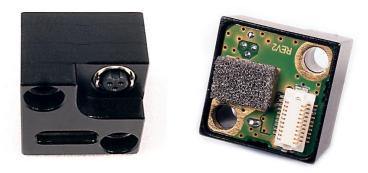


figure 3-15, ADPT-MU9P-USB2-UB-V connection diagram

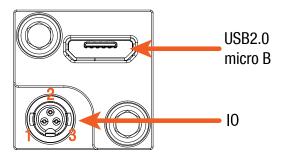


figure 3-16, ADPT-MU9P-USB2-UB-V IO pinout

### I/O connector Pin Assignment:

Pin	Signal	Technical description
1	GPIO 1	Programmable IO
2	Common (IO Ground)	
3	GPIO 2	Programmable IO
(Shell)	Chassis ground	

table 3-10, ADPT-MU9P-USB2-UV-V I/O connector, Pin Assignment

## Camera Board Interface MicroB - Type USB Interface

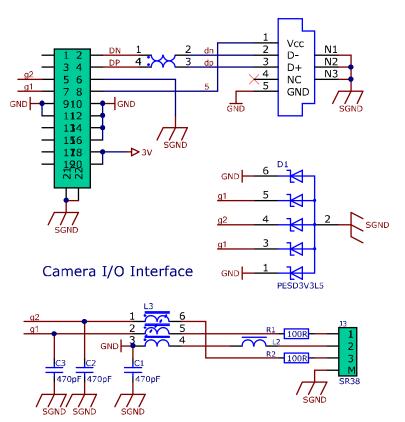


figure 3-17, ADPT-MU9P-USB2-UB-V connection diagram

## 3.2.11. ME-ADPT-MU-T

xiMU series tripod mounting bracket

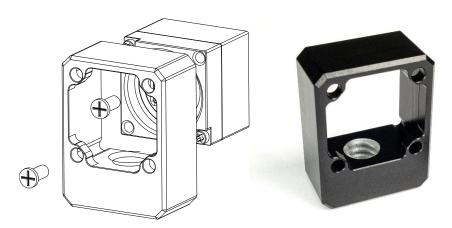


figure 3-18, ME-ADPT-MU-T Mounting tripod bracket

Use 2x SROB-M2x4-CUST screws (included) for mounting. The camera can be mounted in all four orientations in the bracket.

## 3.2.11.1. Dimensional drawing

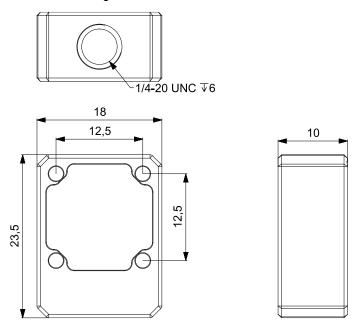


figure 3-19 ME-ADPT-MU-T, dimensional drawing

## 3.2.12. CBL-MQSYNC-3M0

3.0m xiQ series I/O sync cable can be used with ADPT-MU9P-USB2-UB-V, pig tail

### Cable drawing

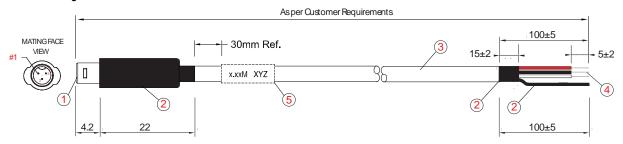


figure 3-20, drawing sync cable

#### Cable components

Item	Description	
1	HRS SR38-4P-3P (71)	
	Hirose SR38 Series Male Connector	
2	Heat Shrink Tube	
3	A12-1709 [OD=3.30mm] <blk></blk>	
	(10/0.120x3C) + 32/0.120 27AWG 3Core Line Cord	
4	Process end with wire end Striped and tin-plated soldering	
5	Cable Label	

table 3-11, sync cable, components

#### Sync cable wiring

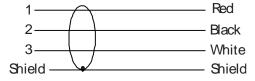


figure 3-21, wiring sync cable

### Pin Assignment:

Pin	color	Signal
1	Red	GPIO 1
2	Black	Common (IO Ground)
3	White	GPIO 2

table 3-12, sync cable, pin assignment

## 3.2.13. Scope of delivery (MU9Px-MH)

Standard delivery of the camera includes:

Camera MU9Px-MH

# 3.2.14. Scope of delivery (MU9Px-MH-KIT)

Standard delivery of the camera kit includes:

- Camera MU9Px-MH
- Lens mount adapter MECH-MU9-MH-ADAPT-M (see <u>3.2.6.1 MECH-MU9-MH-ADAPT-M, dimensional drawing</u>)
- Lens mount adapter MECH-MU9-MH-ADAPT-L (see <u>3.2.6.2 MECH-MU9-MH-ADAPT-L</u>, <u>dimensional drawing</u>)

## 3.2.15. Scope of delivery (MU9PX-MBRD)

Standard delivery of the camera includes:

Board level camera MU9Px-MBRD

Please see the pictures below:

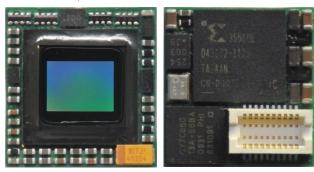


figure 3-22, MU9Px-MBRD

## 3.2.16. Scope of delivery MU-MINIUSB

Standard delivery of the MU-MINIUSB-board includes

- MU-MINIUSB adapter board
- 2 screws M3

Please see the picture below:



figure 3-23 MU-MINIUSB with screws



# 3.2.17. Scope of delivery ADPT-MU9P-USB2-UB-V

Standard delivery of the ADPT-MU9P-USB2-UB-V includes

- ADPT-MU9P-USB2-UB-V adapter board
- 2 screws M3x10

Please see the picture below:



figure 3-24 ADPT-MU9P-USB2-UB-V with screws

# 3.3. xiMU USB3.1 Gen1 Specification

# 3.3.1. Sensor and camera parameters

xiMU model		MU181CR-ON
Sensor parameter		
Brand		Onsemi AR1820HSSC12SHEA0-DP
Color filter		RGB Bayer mosaic
Туре		Rolling shutter, Global Reset Release
Pixel Resolution ( $H \times V$ )	[pixel]	4896 × 3680
Active area size $(H \times V)$	[mm]	$6.1 \times 4.6$
Sensor diagonal	[mm]	7.6
Optical format	[inch]	1/2.3
Pixel Size ( $H \times V$ )	[µm]	1.25
ADC resolution	[bit]	12
FWC	[ke-]	4.5
Dynamic range	[dB]	57.6
SNR Max	[dB]	36.3
Conversion gain	[e-/LSB <sub>12</sub> ]	1.18
Dark noise	[e-]	6
DSNU	[e-]	1.2
PRNU	[%]	<1.5
Linearity	[%]	<1
Camera parameters		
Supported bit resolutions	[bit/pixel]	8,10,12
Exposure time <sup>2</sup>	[µs]	18 - 5000000
Variable gain range	[dB]	0-24
Maximum frame rate <sup>1</sup>	[fps]	21.9 / 17.5 / 14.6
Power consumption		
typical	[W]	1.4
Maximum	[W]	1.6
Idle	[W]	0.7
Dimensions/Mass		
$Height \times width \times depth$	[mm]	15 × 15 × 13.6
mass	[g]	5.1(without lens mount adapter)

table 3-13, MU181 sensor and camera parameters

#### Notes:

- The figure indicates the maximum achievable frame rate for full frame readout for 12,10- and 8-bit resolutions. The real performance will be affected by USB controller, number and type of USB devices attached to this controller, system processor and memory speed and configuration.
- 2) Minimal exposure depends on readout mode and bandwidth limitation.



Binning/skipping	pixels	fps	Bit/px
1x1	4896 x 3680	21.9	8
1x1	4896 x 3680	17.5	10
1x1	4896 x 3680	14.6	12
2x2 bin	2448 x 1842	59.4	8
2x2 bin	2448 x 1842	59.4	10
2x2 bin	2448 x 1842	58.3	12
4x4 bin+skip	1224 x 920	115.9	8
4x4 bin+skip	1224 x 920	115.9	10
4x4 bin+skip	1224 x 920	115.9	12

table 3-14, MU181 readout modes

# 3.3.2. Quantum efficiency curves [%]

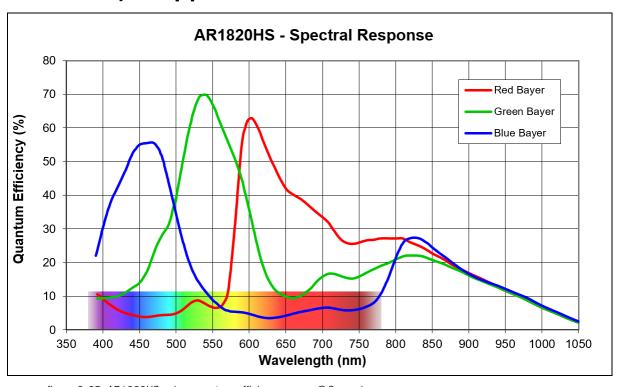


figure 3-25, AR1820HS color, quantum efficiency curve, ©Onsemi

# 3.3.3. Dimensional drawings

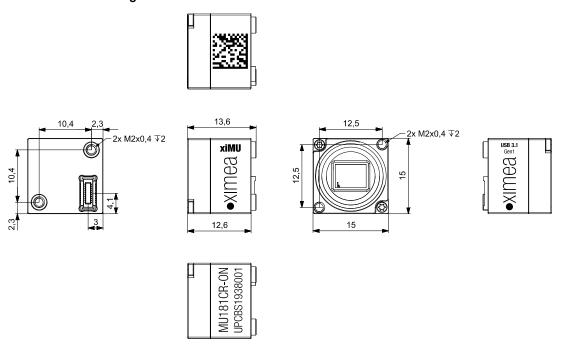


figure 3-26, MU181CR-ON, dimensional drawing

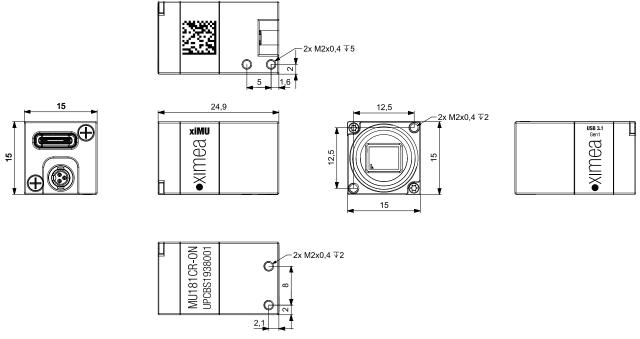


figure 3-27, MU181CR-ON with ADPT-MU-TC-V, dimensional drawing



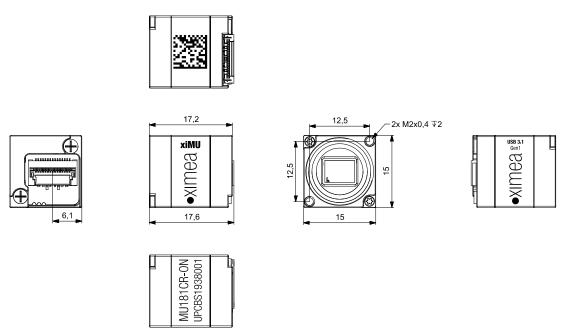


figure 3-28, MU181CR-ON with ADPT-MU-FL, dimensional drawing

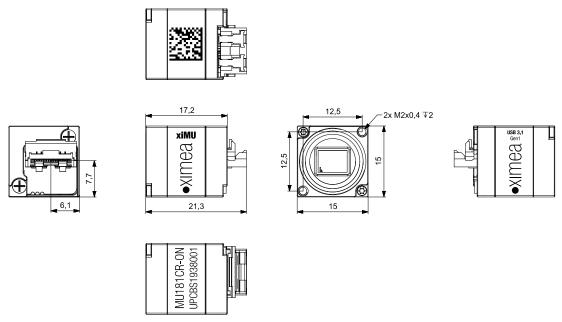


figure 3-29, MU181CR-ON with ADPT-MU-FV, dimensional drawing

## 3.3.4. Camera features

feature	Note
Binning	Yes: 2x2
Skipping	Yes: 2x2, only if binning 2x2 is enabled
ROI	Yes, 16-pixel granularity
HW Trigger	Trigger without overlap usable (see 4.3.2.3 Triggered mode)
Image formats	RAW, (RGB24, RGB32 – only color models)

table 3-15, MU181 sensor features

# 3.3.5. MU181 Lens Mount Adapters

There are two lens mount adapters available (S-Mount, M12 x 0.5 thread).

# 3.3.5.1. ME-LA-MU-M12-M, dimensional drawing



figure 3-30, lens mount adapter ME-LA-MU-M12-M, image

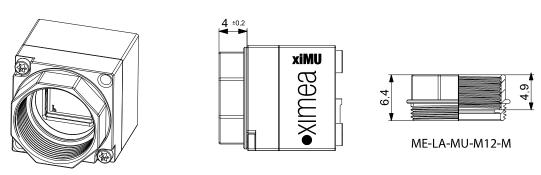


figure 3-31, lens mount adapter ME-LA-MU-M12-M, drawing

Geometric Back focal Distance (measured from the top of the flange to the top of the sensor die): 8 mm.

# 3.3.5.2. ME-LA-MU-M12-L, dimensional drawing



figure 3-32, lens mount adapter ME-LA-MU-M12-L, image

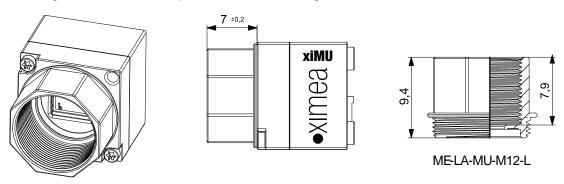


figure 3-33, lens mount adapter ME-LA-MU-M12-L, drawing

Geometric Back focal Distance (measured from the top of the flange to the top of the sensor die): 11 mm.

# 3.3.6. MU181CR-ON Camera connector (USB / IO Interface)

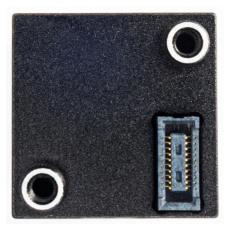


figure 3-34 MU181CR-ON Camera connector, image

The connector mounted on the camera PCB is a

HRS DF40HC(3.5)-20DS-0.4V(51)

# 3.3.6.1. Location and Pinout

The camera connector is located on the back side of the camera:

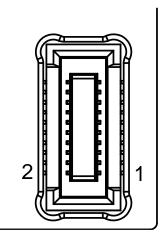


figure 3-35, MU181CR-ON camera connector, location and pin-out



# 3.3.6.2. Signal description

MU181 camera connector pin assignment and signal description:

Pin	Signal	Description	Function			
1	GX1	Programmable IO	default setting exposure active output (Vin-High 2V MAX)			
2	SGND	Chassis ground -				
3	GX2	Programmable IO	defined by user; default setting trigger input (Vin-High 2V MAX)			
4	GND	Ground	Ground for power and data lines			
5	GX3	Programmable IO	defined by user; default setting OFF (Vin-High 2V MAX)			
6	SS_RX_N	USB 3.0 interface	USB 3.0 super speed LVDS receiver neg.			
7	TCX_INT	NC	(do not connect)			
8	SS_RX_P	USB 3.0 interface	USB 3.0 super speed LVDS receiver pos.			
9	SCL	(NC)	(do not connect)			
10	GND	Ground	Ground for power and data lines			
11	SDA	(NC)	(do not connect)			
12	SS_TX_P	USB 3.0 interface	USB 3.0 super speed LVDS transmitter pos.			
13	GND	Ground	Ground for power and data lines			
14	SS_TX_N	USB 3.0 interface	USB 3.0 super speed LVDS transmitter neg.			
15	SS_D_P	USB 2.0 interface	USB 2.0 LVDS pair pos.			
16	GND	Ground	Ground for power and data lines			
17	SS_D_N	USB 2.0 interface	USB 2.0 LVDS pair neg.			
18	VBUS	USB power supply	Power input 5V (1.9W max)			
19	GND	Ground	Ground for power and data lines			
20	VBUS	USB power supply	Power input 5V (1.9W max)			

table 3-16, MU181CR-ON camera connector, signal description

#### Notes:

- None of the pins is galvanically isolated
- The IO pins are connected to the FPGA via 100  $\Omega$  serial resistor and ESD protection

#### 3.3.6.2.1.

#### Ground

3.3.6.2.2.

This signal connected to the internal signal ground

# GX1, GX2, GX3 - Programmable IO

These pins are connected to the FPGA pins via serial resistors of  $100\Omega$ , all signals are ESD protected.



# 3.3.6.3. GXn electrical characteristics

Item	Parameter	Note	
Number of digital lines	3	Each line can be configured by application separately as input or output	
Maximal input voltage	2V DC		
Common pole	YES		
Effect of incorrect input terminal connection	Reverse voltage can damage the camera		
Effects when withdrawing/inserting input module under power	May damage camera electronics		
Protection	ESD and EMI protection	ESD IEC 61000-4-2 (Level 4), PI-filter (R = 100 $\Omega$ , CTOTAL = 30 pF)	
Maximal output sink current	2mA		
Inductive loads	NO		
Output Level logical 0	< 0.2V	Load 100k0hm	
Output Level logical 1	> 1.5V	Load 100k0hm	
Output delay - rising edge	<10ns	Load 100k0hm threshold 1.5V	
Output delay - falling edge	<10ns	Load 100k0hm threshold 0.5V	
Input Impedance- minimum	15k0hm		
Input Level for logical 0	< 0.3V		
Input Level for logical 1	> 0.9V		
Input debounce filter	NO		
Input delay - rising edge	<10ns	VINPUT=1.8V	
Input delay - falling edge	<10ns	VINPUT=1.8V	
Input functions	Trigger	Both edges are supported for trigger	
Output functions	Off, On, Exposure active, Frame active	Signal inversion supported	

table 3-17, MU181CR-ON IO ports GXn, electrical characteristics

# 3.3.7. ADPT-MU-FL, ADPT-MU-FV



figure 3-36, ADPT-MU-FL,



figure 3-37, ADPT-MU-FV,

Weight (with screws): 1.4 g (please see 3.3.15 Scope of delivery ADPT-MU-FL/ADPT-MU-FV)

# 3.3.7.1. Flex Connection Location

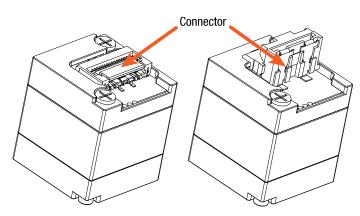


figure 3-38, ADPT-MU-FL/ ADPT-MU-FV

Variant	Connector	Note
-FL	Molex 502244-1530	
-FV	Molex 502231-1500	

table 3-18 Connectors

# 3.3.7.2. Pinning

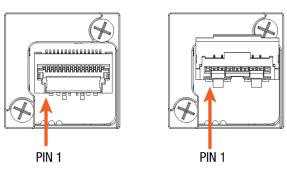


figure 3-39, ADPT-MU-FL/ ADPT-MU-FV pin one location

Pin	Signal	Technical description		
1	GND	Ground for power return and for SuperSpeed signal return		
2	SSRX-	SuperSpeed receiver dif. pair (accepts reverse polarity)		
3	SSRX+	SuperSpeed receiver dif. pair (accepts reverse polarity)		
4	GND	Ground for power return and for SuperSpeed signal return		
5	SSTX+	SuperSpeed transmitter dif. pair (accepts reverse polarity)		
6	SSTX-	SuperSpeed transmitter dif. pair (accepts reverse polarity)		
7	GND	Ground for power return and for SuperSpeed signal return		
8	D+	USB 2.0 differential pair		
9	D-	USB 2.0 differential pair		
10	GND	Ground for power return and for SuperSpeed signal return		
11	VBUS	+5V Power input		
12	VBUS	+5V Power input		
13	OUT1	Trigger/sync digital Output (GPO) - Open collector NPN		
14	IN/OUT GND	Common pole (IO Ground		
15	IN1	Trigger/sync digital Input (GPI) Current limited input		
Ground pins	SGND	Shield of FPC cable connected to shield of host controller		

table 3-19 Pin list for flex cable

# 3.3.7.3. IO lines specification

Item	Parameter	Note
Number of digital lines	1	
Maximal input voltage	24V DC	
Common pole	YES	
Effect of incorrect input terminal connection	Reverse voltage polarity protected	
Effects when withdrawing/inserting input module under power	no damage, no lost data	
Protection	Reverse voltage, ESD	
Input Impedance- minimum	15kΩ	
Input Level for logical 0	< 0.3V	
Input Level for logical 1	> 1.3V	
Input debounce filter	NO	
Input delay - rising edge	<300ns	VINPUT=2V
Input delay - falling edge	<450ns	VINPUT=2V
Input functions	Trigger	Both edges are supported for trigger

table 3-20, Digital Input (IN1), electrical characteristics

Item	Parameter	Note
Number of digital lines	1	
Common pole	YES	
Effects when withdrawing/inserting input module under power	no damage, no lost data	
Protection	ESD and short circuit	ESD HBM ANSI/ESDA/JEDEC JS-001 Class 2 exceeds 2 kV; CDM JESD22-C101E exceeds 1000 V
Output Level logical 0	< 0.8V	Load 100k0hm
Output Level logical 1	> 3.7V	Load 100k0hm
Output delay - rising edge	<20ns	Load 100kOhm threshold 1.5V
Output delay - falling edge	<20ns	Load 100kOhm threshold 0.5V
Output functions	Off, On, Exposure active, Frame active	Signal inversion supported

table 3-21, Digital Output (OUT1), electrical characteristics

# 3.3.7.4. IO Connection to camera

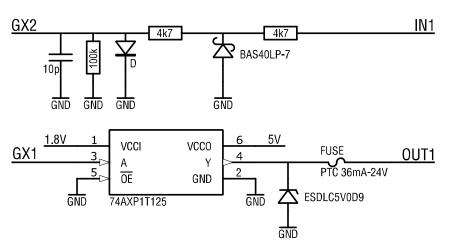


figure 3-40, ADPT-MU-FL ADPT-MU-FV and ADPT-MU-TC-V, IO connection diagram

For details about the signal description please see. 3.3.7.3 IO lines specification



#### 3.3.7.5. Inserting / detaching FPC cable

When inserting or detaching cables increased caution need to be taken, to prevent connector or cable damage. MU181 cameras interface connectors are equipped with locking mechanism. Do not pull on the cable if connector is locked as it may damage the connector or the camera. When manipulating with cable the power supply for the camera must be turned off.



Cables PN: CBL-MQ-FL-xxx (gold) have marked ends. It is important to connect the end marked "CAM" to the camera and end marked "BOB" to host or adapter. Swapped orientation can cause damage to camera. It is important that the power is turned off when inserting/detaching the cable.



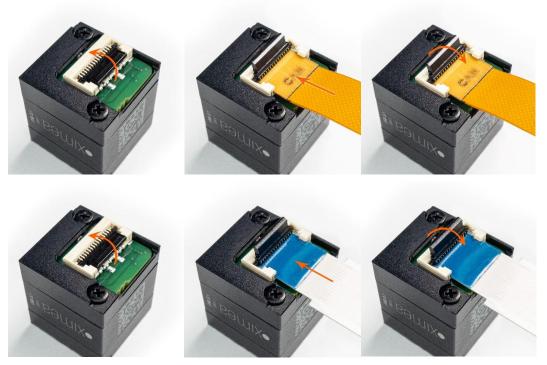
figure 3-41, FPC cable CBL-MQ-FL-xxx laser marking

Cables PN: CBL-USB3FLEX-xxx (white) are not polarized therefore the orientation of the cable between camera and host is not important.



figure 3-42, FPC cable CBL-USB3FLEX-xxx ends

Inserting FPC cable MU option -FL



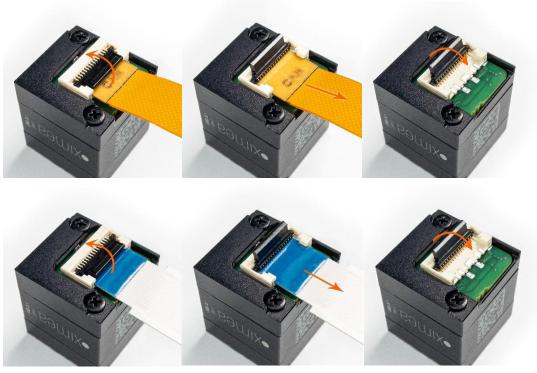
1. Open connector lock

2. Insert cable (contact facing down)

3. Close connector lock

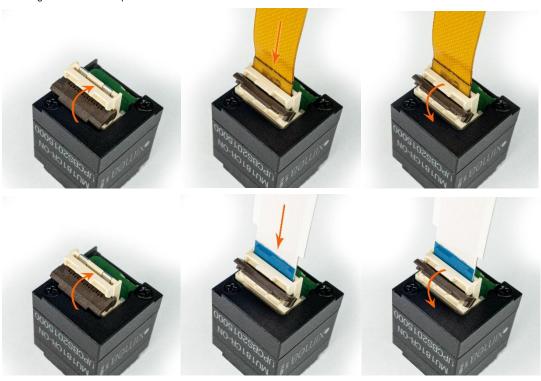
figure 3-43, FPC insert procedure option -FL

# Detaching FPC cable MU option -FL



1. Open connector lock 2. Pull cable gently in marked direction 3. Close connector lock figure 3-44, FPC detach procedure option -FL

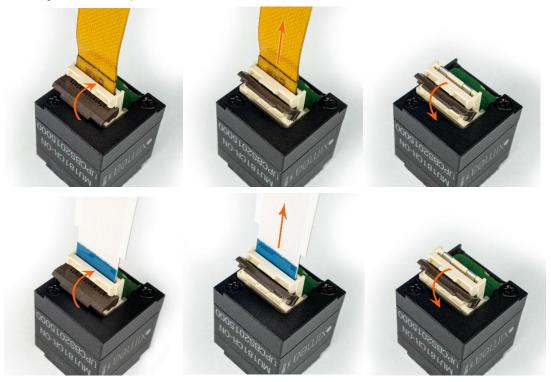
# Inserting FPC cable MU option -FV



1. Open connector lock 2. Insert cable figure 3-45, FPC insert procedure option -FV

3. Close connector lock

Detaching FPC cable MU option -FV



1. Open connector lock 2. Pull cable gent figure 3-46, FPC detach procedure option -FV

# 3.3.8. ADPT-MU-TC-V

This adapter provides standard Type-C USB 3.1 Gen 1 connector and IO connector (SR38) with IN1 and OUT1 accessible.



figure 3-47, ADPT-MU-TC-V

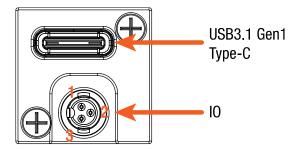


figure 3-48, ADPT-MU-TC-V IO pinout

# 3.3.8.1. IO connector Pinout

I/O connector Pin Assignment:

Pin	Signal	Technical description
1	IN 1	Non isolated input connected with GX2
2	Common (IO Ground)	
3	OUT 1	Non isolated output connected with GX1
(Shell)	Chassis ground	

table 3-22, ADPT-MU-TC-V I/O connector Pin Assignment

For IO lines connection and specification please see chapter 3.3.7.4 IO Connection to camera and 3.3.7.3 IO lines specification

## 3.3.9. ME-ADPT-MU-T

Please refer to section 3.2.11 ME-ADPT-MU-T

### 3.3.10. CBL-MQSYNC-3M0

Please refer to section 3.2.12 CBL-MQSYNC-3MO

### 3.3.11. CBL-MQ-FL-0M1, CBL-MQ-FL-0M25

Cable FPC MQ Flex-Line, 0.1m/0.25m can be used for connecting xiMU flex line models to carrier board or trough adapter and standard USB 3.0 cable to the host computer. Minimal advised bending radius is 2mm. Cable thickness 0.16mm.



figure 3-49, flex cable gold color

Cable have marked ends. It is important to connect the end marked "CAM" to the camera and end marked "BOB" to host or adapter. Swapped orientation leads to nonoperational state. Connecting camera to powered host can cause destruction of camera. For detaching the cable the connector needs to be unlocked, otherwise connector soldering may be damaged.





figure 3-50, flex cable ends

# 3.3.12. CBL-USB3FLEX-0M10, CBL-USB3FLEX-0M25, CBL-USB3FLEX-0M50

The newer generation of FFC cable with available lengths 0.1m, 0.25m and 0.5m can be used for connecting camera to carrier board or through adapter to the host computer (see <u>3.3.7.5 Inserting / detaching FPC cable</u>). Minimal advised bending radius is 5mm. Cable thickness 0.38mm. This cable is NOT polarized and either end can be used for the camera or the host.



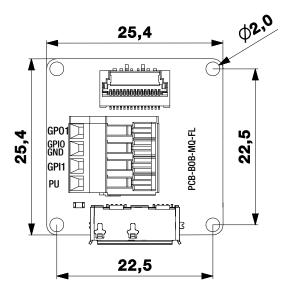
figure 3-51, flex cable white color

# 3.3.13.BOB-MQ-FL

Break Out Board, Simple Board Level. Enables access to the input and output. FPC cable connector pinout is exactly mirrored from camera pinout. Please refer to



figure 3-52, drawing USB3 cable



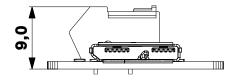


figure 3-53, BOB-MQ-FL dimensions

Pin	Signal Description	
1	IN 1	Non isolated input connected with GX2 (TTL 5V)
2	Common (IO Ground)	
3	OUT 1	Non isolated output connected with GX1 (TTL 5V) push-pull
4	PU	Pull up 1k0hm to 0UT1 – Do not use for these cameras

table 3-23, IO connector (WAGO 218-104), pin assignment

# 3.3.14. Scope of delivery MU181CR-ON models

Standard delivery of the various camera models includes:

- MU181CR-ON: MU181CR-ON camera (only available for OEM projects)
- MU181CR-ON-FL: MU181CR-ON camera + ADPT-MU-FL adapter screwed together
- MU181CR-ON-TC: MU181CR-ON camera + ADPT-MU-TC-V screwed together

# 3.3.15. Scope of delivery ADPT-MU-FL/ADPT-MU-FV

Standard delivery of the camera includes:

- ADPT-MU-FL or ADPT-MU-FV in mechanics
- 2 screws M2x4 custom

Please see the pictures below:





figure 3-54, ADPT-MU-FL/ADPT-MU-FV

# 3.3.16. Scope of delivery ADPT-MU-TC-V

Standard delivery of the ADPT-MU-TC-V includes

- ADPT-MU-TC-V adapter with mechanics
- 2 screws M2x10 custom

Please see the picture below:



figure 3-55 ADPT-MU-TC-V with screws



# 3.3.17. Scope of delivery ME-ADPT-MU-T kit

Standard delivery of the ME-ADPT-MU-T includes

- ME-ADPT-MU-T adapter board
- 2 screws M2x3 custom

Please see the picture below:



figure 3-56 ME-ADPT-MU-T with screws



# 4. Operation

For a proper operation of your xiMU camera certain requirements must be met. You will read more about these requirements in the following chapters, as well as a description of how to use a xiMU camera.

# 4.1. System Requirements

## 4.1.1. Software Requirements

The xiMU cameras are compatible with the following operating systems:

- Windows 7 SP1
- Windows 10
- Linux Ubuntu
- MacOS 10.8 or newer



All XIMEA cameras are compatible with the most advanced Vision and Image Processing Libraries.

See chapter <u>5 Software</u> for more information about the options to access a xiMU cameras, as well as a list of currently supported libraries and frameworks supported under Windows.

### 4.1.2. Hardware Requirements

The XIMEA xiMU USB2.0 cameras are compatible with USB 2.0. System Configuration. The computer system must have a USB 2.0 High-speed interface. For the xiMU USB3.1 Gen1 the computer must have a supported USB3.0 controller. The list of supported USB3.0 controllers can be found on our Compatible USB3 Hardware support page.

### 4.2. Video Formats

#### 4.2.1. Full Resolution

By default, each camera outputs a full resolution image based on its sensor specification.

### 4.2.2. ROIs – Region Of Interest

ROI, also called area-of-interest (AOI) or windowing, allows the user to specify a sub-area of the original sensor size for read-out. xiMU cameras support the definition of one single ROI by specifying the size (width and height) as well as the position (based on upper left corner) of the of the sub-area.

Since the utilized CMOS sensors rely on the output of full lines, only the decrease of lines, i.e. the vertical resolution, results in an increase of frame rate.

### 4.2.3. Downsampling Modes

Downsampling describes the possibility of reducing the image resolution without affecting the sensors physical size, ie. Without cropping the image. This feature is useful when optics are used, that are particularly fitted to a certain sensor size and if it is necessary to maintain the full image circle on the sensor.

Downsampling can be achieved in two ways: binning and skipping/decimation.



### 4.2.3.1. Binning

When binning is applied, the image is divided into cluster of  $k \times k$  pixels, where all pixel values in each cluster are summed or averaged and treated as one output pixel. For example, a  $2 \times 2$  binning produces  $2 \times 2$  pixel clusters and results in images with 1/2 of the original horizontal and vertical resolution.

# 4.2.3.2. Skipping/Decimation

When skipping is chosen, only every n-th pixel is used to create the output image.

For example, with a 2×2 skipping the sensor is divided into 2x2 pixel arrays, and only on pixel of the array is read and transmitted, the rest are discarded. Skipping/Decimation is usually faster than binning mode, but also introduces more aliasing effects.

### 4.2.4. Color and Mono Modes

All modes are provided by the xiAPI or standard interfaces using the xiAPI (please see section <u>5.1 Accessing the Camera</u>). Each xiMU cameras supports several mono (black-and-white) output modes.

Mode	Description	
RAW8	Raw sensor data, 8 Bit per pixel, single channel	
RAW16	Raw sensor data, 16 Bit per pixel, single channel	
	10 or 12 Bit sensor output (LSB)	
MON08	Intensity output, 8 Bit per pixel, single channel	
MONO16	Intensity output, 16 Bit per pixel, single channel	

table 4-1, image formats, mono

Color camera models also support additional color modes.

Mode	Description
RGB24	RGB filtered output, 24 Bit per pixel, 3 channels Sequence: [Blue][Green][Red]
RGB32	RGBA filtered output, 32 Bit per pixel, 4 channels, Alpha channel equals 0. Sequence: [Blue][Green][Red][0]
RGB_PLANAR	RGB filtered output with planar-oriented channels.  Format: [R][R][G][G][B][B]

table 4-2, image formats, color

Note1: For color modes **RGB32** and **RGB24** the image from sensor needs to be pre-processed (de-bayering). CPU load is higher in these modes. Setting this parameter will reset current region of interest. **RGB24** is being processed from the **RGB32** by removing the unused Alpha channel creating a slightly higher CPU load then the **RGB32** format.

# 4.3. Acquisition modes

### 4.3.1. Free-Run

Also known as continuous acquisition. In this mode the sensor delivers a constant stream of image data at the maximum speed available by the current bandwidth, without any external trigger. Each image exposition is started automatically when possible.

For all sensors the exposure of the next frame overlaps with the data readout of the previous frame.

This Overlapped mode gives the highest number of frames per second (FPS).

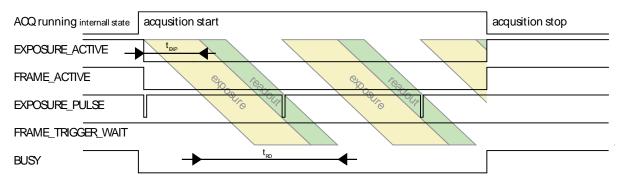


figure 4-1, acquisition mode - free run

In this mode the timing depends on minimum of Exposure Time and Data Readout Time.

# 4.3.2. Triggered Acquisition

Unlike in the free-run, each image exposition can also be triggered with an input trigger signal. In this mode, the sensor waits in stage until the trigger signal arrives. Only then, the exposure is started, which is followed by the data readout.

### 4.3.2.1. Software Trigger

The trigger signal can be sent to the sensor using a software command. In this case, common system related latencies and jitter apply.

# 4.3.2.2. Hardware Trigger

A hardware trigger can be send to the sensor using the digital input described in <u>3.2.7.2 Signal description</u> and <u>3.3.6.2 Signal description</u>. Triggering by hardware is usually used to reduce latencies as well as jitter in applications that require the most accurate timing.



### 4.3.2.3. Triggered mode

This mode gives lower FPS compared to *Free-Run* mode. Sensor support two modes of exposure which have impact on camera signaling.

#### Sensor timing in global reset release mode

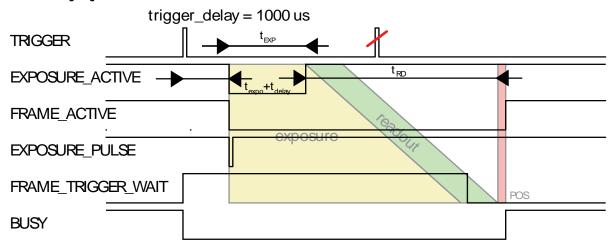


figure 4-2, acquisition mode - triggered global reset release

In this mode the timing depends on sum of:

- Input transition time (t<sub>itr</sub>), depends on:
  - Digital Input Delay time for changing internal circuit to active state. It is constant for each camera model. For this
    camera it is negligible.
  - $\circ$  Trigger delay ( $t_{delay}$ ) delay set in camera to postpone trigger to sensor.
- Exposure time (t<sub>exps</sub>) Exposure time.
- Data Readout time  $(t_{rd})$  Depends on mode of operation, no direct calculation possible.
- Post image timeout (tpos) time after image readout need by sensor to be ready for next exposure.

#### Typical times for selected camera models

Camera Model	DownS	t <sub>itr</sub> [µs]	t <sub>exp</sub> [µs]	t <sub>eio</sub> [µs]	t <sub>expo</sub> [µs]	t <sub>rd</sub> [µs]	Notes
MU9Px-MH	any		2	0.5	1.5		
MU181CR-ON							

table 4-3, trigger mode w/o overlap, timing

#### Description:

DownS = Current camera DownSampling (XI\_PRM\_DOWNSAMPLING)

t<sub>eio</sub> = Trigger (Digital Input) to Strobe (Digital Output)

 $t_{exp}$  = Strobe (Sensor) to Digital Output

 $t_{delay} \quad = Trigger \ delay$ 

 $t_{\text{expo}}$  = Start of exposition to Exposure Active Digital Output

LC = Current Line Count (XI PRM HEIGHT)

 $t_{exps}$  = Current Exposure Time set (XI\_PRM\_EXPOSURE)

# Minimum trigger period (Ttrig\_min)

Minimum trigger period can be calculated using the following formula:

$$t_{trig\_min} = t_{exps} + t_{rd} + t_{pos} \\$$

Example for MU9P full resolution, Exposure time =  $500\mu$ s, image = 500 pixels width x 200 pixels height (Full line length is readout each time including optical black pixels = 2624pixel. Additional lines are readout as well):

$$t_{trig\_min} = 500\mu s + 110\mu s * 211lines + 200\mu s = 23.91ms$$

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# Sensor timing in rolling shutter mode

Similar to global reset release mode, except exposure is done in rolling shutter mode

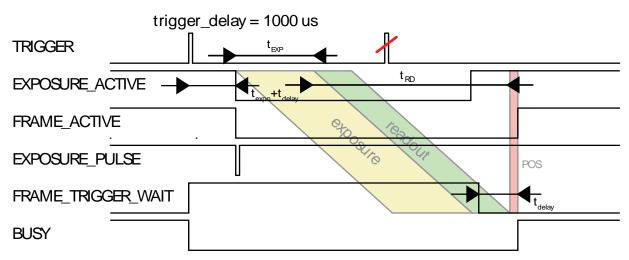


figure 4-3, acquisition mode – triggered rolling shutter mode

For description please see previous page.



# 4.4. Sensor Shutter Modes

XiMu cameras can be operated in two shutter modes, Rolling Shutter or Global Reset Release.

The *Rolling Shutter* mode is used if the camera is operated in free-run mode. If the camera is triggered, either by hardware trigger or through software, the sensor uses the *Global Reset Release mode*.

# 4.4.1. Rolling Shutter Mode

- Line by line integration state
- Line by line transfer and readout
   Integration of next line is delayed by readout time of one line

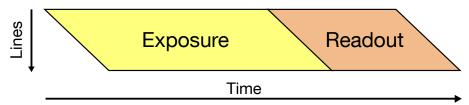


figure 4-4, rolling shutter mode - schematic

#### Artifacts caused by subject movement

Because of the sequential start of the exposure, the rolling shutter mode may introduce artifacts effect if objects move. In the direction of the lines (horizontal) the image will be sheared. When moving in vertical direction, the object may appear longer or shorter.



figure 4-5, rolling shutter mode, image of a horizontally moved object

When the exposure is longer also motion blur may occur



figure 4-6, rolling shutter mode, image of a horizontally moved object, long exposure time



Rolling shutter artifacts may be prevented by using a flash or stroboscopic light. The flash or strobe must occur when all lines are exposed simultaneously. The exact timing depends on sensor type and readout timing.

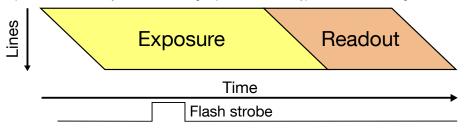


figure 4-7, rolling shutter mode with flash - schematic

In Rolling shutter mode all lines are triggered consecutively, and a strobe must be timed so that it does not start before all lines are open. The delay can be calculated from the highest frame rate and is 1/fps. The strobe must also end before the first lines are closed again for exposure, which sets a lower limit for the exposure time, as can be seen in the figure above.

#### 4.4.2. Global Reset Release Mode

- Global reset of all photo diodes
- Integration stage
- Transfer, conversion and readout line by line starts at the end of the integration of the first line. Not transferred line stays in
  integration stage until readout of particular line starts. This leads to different exposure time for individual lines. Each next line
  has exposure longer by readout of one line.

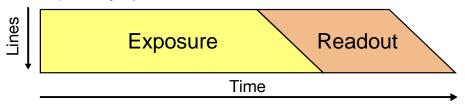


figure 4-8, global reset release mode - schematic

#### Artifacts caused by subject movement

Because of the longer exposure of the lower lines they may be show increased blurring if the object moves.



figure 4-9, global reset release mode, image horizontally moved object

To freeze the motion, a flash may be used. In contrast to rolling shutter mode the flash strobe does not need to be delayed.

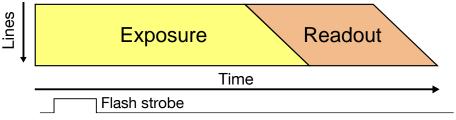
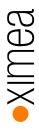


figure 4-10, global reset release mode with flash - schematic



#### 4.4.3. How to Freeze the Motion

When a moving object (e.g. on a conveyor belt) is imaged with a longer exposure time, the resulting image will show Motion Blur. To avoid Motion Blur the short exposure times or flash illumination should be used.

Example of a setup with MU9 camera:

```
Sensor width (W) 0.0057m
2520 pixel horizontally (PX)
Field of view (FOV) 0.2m
Conveyor speed (CS) 0.1m/s
```

To contain Motion Blur to within one image pixel the following calculation for the flash light duration may be used:

```
Pixel distance (PD) W/PX -> 0.0057m/2592pixels = 2.2um.

Pixel distance recalculated FOVPD = FOV/PX = 0.2m/2592 = 77.2um

During exposure the object should not move more than 77.2um

Flash Time (FT) should be less than FOVPD/CS = 77.2um/0.1m/s = 0.772ms
```

### 4.5. Camera Parameters and Features

# 4.5.1. Exposure

Also known as shutter speed. This parameter defines the length of the integration period for each frame.

Most of CMOS sensors generate the exposure interval internally. For some it is possible to control it by external signaling. The sensor internal timing depends on the provided system clock. Most sensors are using dividers to generate slower clocks for internal usage.

The exposure time is mostly defined by number row times, where the row time is dependent on various internal settings. Very few sensors support exposure times equal to zero. There is defined minimal exposure time as well as steps between possible exposure times.

#### 4.5.2. Gain

The gain value influences the analog-to-digital conversion process of the image sensor pipeline and acts as a multiplier of the output signal. Using gain values greater than 0 will increase the pixel intensities but may also increase the overall noise level.

# 4.6. Host-Assisted Image Processing Parameters Available in xiAPI.

### 4.6.1. Auto Exposure – Auto Gain

When AEAG is used, every captured image is evaluated for its mean intensity. Based on the result, the exposure and gain values are modified with the objective to achieve a target intensity level for the following image. Further, the maximum applicable exposure and gain values can be defined. Since both, exposure and gain, have an influence on the intensity, the ratio between those two parameters in their contribution to the algorithm can also be set (exposure priority).

#### 4.6.2. White Balance

Only for color models: The white balance can be adjusted with three coefficients kR, kG and kB, one for each color channel. These coefficients can be set individually in order to increase or decrease each channel's contribution and therefore allow the user to control the color tint of the image.

#### 4.6.2.1. Assisted Manual White Balance

This feature measures the white balance a single time and sets the white balance coefficient to achieve a mean grey (neutral) tint.



The measurement is performed on the central rectangle of the image, with 1/8<sup>th</sup> of its width and height. The function expects a white sheet of paper exposed to 50% of the intensity values (8 Bit RGB values should be around 128) to be visible.

#### 4.6.2.2. Auto White Balance

The white balance is measured across the full image for every 4<sup>th</sup> image that is acquired and the white balance coefficients are set to achieve a neutral color tint.

#### 4.6.3. Gamma

Only for color models: As a part of the color filtering process, it is possible to adjust the gamma level of the image. The adjustment can be set separately for the luminosity and the chromaticity.

# 4.6.4. Sharpness

Only for color models: As a part of the color filtering process, it is possible to adjust the sharpness of the image.

#### 4.6.5. Color Correction Matrix

The color correction matrix is a 4x4-matrix which is applied on each pixel of an image in a host-assisted port-processing step. This Matrix can be used for example to adjust the brightness, contrast, and saturation.

# 4.6.6. Bad pixel Correction

During manufacturing, every camera is going through a testing procedure where hot pixels are measured based on dark field images. The measured hot pixels are stored inside the camera and are used for the correction of the acquired images during operation. The correction is active by default but can be turned off by the user if a non-processed output is required.

### 4.7. MU9 USB2.0 Transfer Modes

### 4.7.1. Transfer mode

MU9 cameras are connected to PC with USB 2.0. BULK data transfer is used. It guaranties data delivery, but it doesn't guarantee constant bandwidth.

# 4.7.2. Packet Size Setting

#### Only for Windows operating systems.

The MU9 cameras have two transfer packet sizes:

- Compatible-Size packets with 512 bytes are used (default)
- Enhanced-Size packets with 1024 bytes are used

With Compatible-Size packets the camera will work correctly on more USB controllers. With Enhanced-Size packet setting - the camera can deliver an approx. 25% higher frame-rate and lower CPU usage.

**Note** - not all controllers and operating systems support Enhanced-Size packets. Please test your configuration first for stability issues.

**Note** -Since API V3\_17\_05, the communication settings were changed on MU9 cameras to Compatible-Size with 512 bytes per packet mode as default.

To change the camera to Enhanced-Size - where packets with 1024 bytes are used use the registry settings below:

```
[HKEY_CURRENT_USER\SOFTWARE\SoftHard\mm40api]

"usb20pktsize"=dword:00000001
```

To change the camera to Compatible-Size - where packets with 512 bytes are used (default) use the registry settings below:

```
[HKEY CURRENT USER\SOFTWARE\SoftHard\mm40api]
```



#### 4.7.3. Bandwidth control

Different USB host controllers can have different maximum data throughputs. The default behavior of the API is to measure the value of the maximum data throughput of the host controller (available bandwidth) when the camera is opened and limit the data rate (bandwidth limit) to the 80% of the maximum measured value. In case multiple cameras are connected to the same USB controller or target data rates higher than 80% of the maximum throughput are needed, application can manually change the limit the data rate by setting the value of the XI\_PRM\_LIMIT\_BANDWIDTH parameter. For more information see our xiApi manual and the Multiple Cameras Setup support page.

#### 4.7.4. USB HUBs

The maximum possible bandwidth is limited when the xiMU camera is connected through a USB hub. If possible - connect the camera directly to the USB port of the PC.

## 4.7.5. Using multiple MU9 cameras

In case multiple MU9 cameras are used, each camera must be connected to a separate USB2 controller, otherwise streaming will not work properly and the user will observe the "Fifo overflow" message in debug output of the application.

# 4.8. Connecting Two MU9 Cameras with Synchronized Acquisition

Two or more MU9 cameras can be connected with synchronized acquisition of images. To decrease the delay between images the cameras should be interconnected via the strobe/trigger signal.

### 4.8.1. Interconnect Cameras

MU9Px-MH cameras could be synchronized from external source. In this case electrical characteristics in <u>GXn DC electrical</u> <u>characteristics</u> need to be observed. In similar way cameras could be connected with each other. In this case one camera will be used as master to trigger all slave cameras. As the output strength of GPO is limited maximum 2 inputs of MU9Px-MH could be connected to one output as depicted on figure 4-11. This setup ensures low latency between two camera exposures. Latency should be less than 10us.

#### Two cameras interconnection

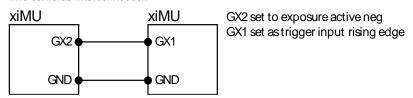


figure 4-11, connecting two MU9 cameras in MASTER-SLAVE (SLAVE on right)

Interconnect the cameras with 2 signals:

- GND (pin 3 on Trigger Plug of MU9 Patch cable [see 3.2.8 MU9 Patch cable])
  - o Connect this pin to same pin on the other camera (GND)
- GX2 (pin 1 on Trigger Plug of MU9 Patch cable [see 3.2.8 MU9 Patch cable])
  - o Connect this pin to pin set as trigger input on other MU9 camera (GX1)
  - o For connecting different model of XIMEA camera signal conditioning may be needed.



#### Multiple cameras interconnection

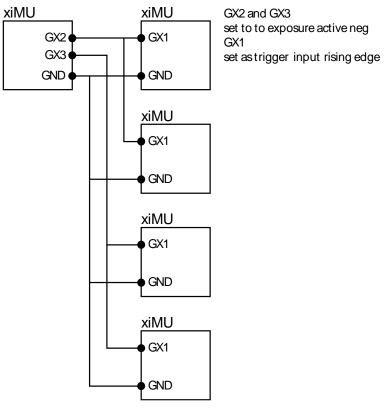


figure 4-12, connecting multiple MU9 cameras in MASTER-SLAVE (SLAVE on right)

To connect different camera model, please consult respective camera model manual for IO connection. In case of different voltage levels signal conditioning may be needed.

#### 4.8.2. Connect Cameras to PC

Connect both cameras to PC.

**Note**: Be sure that each camera is connected to different USB controller. If a camera is connected to the USB hub/controller with other devices present (e.g. camera), the acquisition will not be stable. Please use xiCOP (see <u>5.8 XIMEA Control Panel</u>) to detect connection architecture issues.

#### 4.8.3. Control the Cameras with xiAPI

- Install the latest version of the XIMEA API Software Package
- Open the project example xiSample (c:/XIMEA/Examples/xiSample) in Microsoft Visual Studio
- Replace the file xiSample with the source file from this site: https://www.ximea.com/support/wiki/standard-cameras/Connecting\_Two\_MU9\_Cameras\_With\_Synchronized\_Acquisition

For more information about programming please see 5.7 Programming.

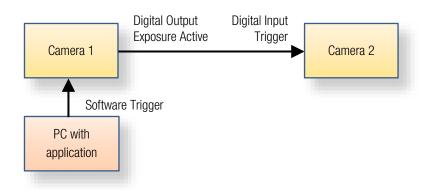


figure 4-13, synchronized acquisition - schematic

#### xiAPI Example:

```
HANDLE handle1, handle2;
// open both cameras
xiOpenDevice(0, &handle1);
xiOpenDevice(1, &handle2);
// set trigger mode on cameral - as master
xiSetParamInt(handle1, XI PRM TRG SOURCE, XI TRG SOFTWARE);
xiSetParamInt(handle1, XI PRM GPO SELECTOR, 1);
xiSetParamInt(handle1, XI PRM GPO MODE,
                                         XI GPO FRAME ACTIVE);
// set trigger mode on camera2 - as slave
xiSetParamInt(handle2, XI PRM TRG SOURCE, XI TRG EDGE FALLING);
xiSetParamInt(handle2, XI PRM GPI SELECTOR, 1);
xiSetParamInt(handle2, XI PRM GPI MODE, XI GPI TRIGGER);
// start
xiStartAcquisition(handle1);
xiStartAcquisition(handle2);
Sleep(1234); // wait for right moment to trigger the exposure
// trigger acquisition on Master camera
xiSetParamInt(handle1, XI PRM TRG SOFTWARE, 0);
// get image from both cameras
xiGetImage(handle1, 100, &image1);
xiGetImage(handle2, 100, &image2);
// process images here
xiCloseDevice(handle1);
xiCloseDevice(handle2);
```

Timing diagram shows the Trigger event, Camera1 and Camera2 Status, Exposure Active Signal from Camera1:

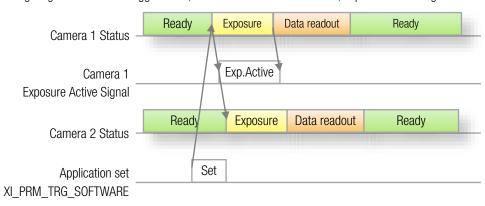
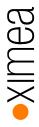


figure 4-14, synchronized acquisition – timing diagram



# Software

# 5.1. Accessing the Camera

Depending on the target application, the user can choose between several ways of accessing and controlling the camera. These can be divided into two categories: a programmatic approach, through programming code, or an integrated approach, through a supported, GUI based software package. The programmatic approach is generally used for the development of a custom application or image processing pipeline. The integrated approach is favored, if the specific toolset of a certain software package is sufficient and the camera serves as an integrated capture device.

## 5.1.1. Proprietary API

All XIMEA cameras are supported by the same unified APIs (application programming interface). The API is a software interface between the camera system driver and the application. Different APIs are available for different programming environments, e.g. *xiAPI* (see <u>5.7.1 XIMEA APIs</u>) for C/C++ developments and *xiAPI.Net* for C#/.Net based developments

#### 5.1.2. Standard Interface

As an alternative to the proprietary API, the camera can be accessed through a set of standard interfaces. These interfaces decouple a specific hardware design (e.g. physical interface) of a camera from its control in software. Therefore, multiple camera classes and types can be used in a unified way.

#### 5.1.2.1. GenlCam

**GenlCam/GenTL** provides a camera-agnostic transport layer interface to acquire images or other data and to communicate with a device. Each camera serves as a *GenTL Producer* which can be accessed in all software packages that are compatible with the GeniCam standard, as well as through custom developments which implement this standard interface.

## 5.1.3. Vision Library Integration

All XIMEA cameras are compatible with the most advanced vision and image processing libraries. For GUI based software packages, the cameras can be directly accessed without the need of programming. Code libraries are generally used in conjunction with one of our APIs, in order to add additional functionality (e.g. image processing, communication, data storage).

# 5.2. XIMEA CamTool

The CamTool is a cross-platform application showcasing the features of all XIMEA camera families.



#### Short description

It runs on Windows, Linux, macOS systems offering a substantial imaging tool set, which can be further extended with custom modules using a plugin infrastructure. CamTool is based on Qt for the UI and xiAPI for the camera control. Its camera settings menu resembles the parameter set of the xiAPI

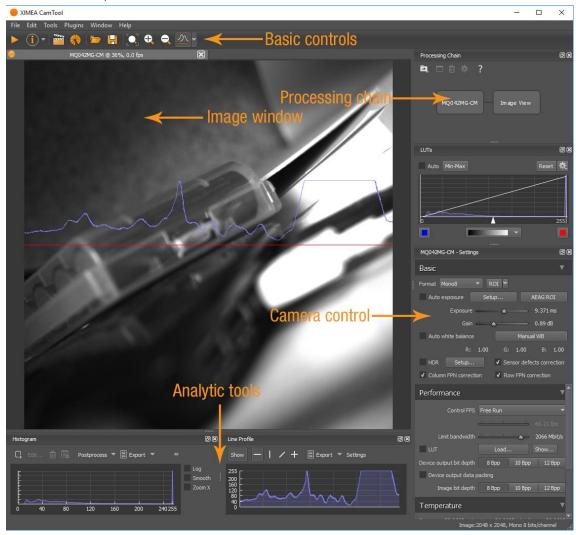


figure 5-1, CamTool Layout



#### **Functions**

- to see live image from multiple XIMEA cameras connected
- control the camera parameters
- store of camera image and video
- analyze the image properties
- histogram and line profile
- image averaging, image flip/mirror
- software trigger timer, save/load camera and program settings
- LUT (Look up table)
- Lua scripting

CamTool allows to operate all connected cameras simultaneously. In this case all control are layered for the cameras. Basic controls are placed as tabs in upper part of the window. Image window can be detached from application if needed. Amount of visible camera controls depend on visibility level which can be set in edit  $\rightarrow$  Options.

For more information, please refer to: https://www.ximea.com/support/wiki/allprod/XIMEA\_CamTool

# **5.3.** Supported Vision Libraries

For an up-to-date listing of the supported vision libraries and software packages, visit our web site <a href="http://www.ximea.com/support/projects/vision-libraries/wiki">http://www.ximea.com/support/projects/vision-libraries/wiki</a>.

# 5.3.1. Libraries maintained by XIMEA

All cameras listed in the section Products are supported with these libraries.

XIMEA commits to update the API within twelve months after a new major release.

XIMEA warranties backwards compatibility of these software packages for two major releases.

#### 5.3.1.1. MathWorks MATLAB



MathWorks® is the leading developer and supplier of software for technical computing and Model-Based Design.

More: http://www.mathworks.de/ or https://www.ximea.com/support/wiki/vision-libraries/MathWorks\_Matlab

#### 5.3.1.2. MVTec HALCON



HALCON is the comprehensive standard software for machine vision with an integrated development environment (IDE) that is used worldwide.

More: http://www.mvtec.com/halcon/ or https://www.ximea.com/support/wiki/vision-libraries/MVTec HALCON

#### 5.3.1.3. National Instruments LabVIEW Vision Library



LabVIEW is a graphical programming environment.

More: http://www.ni.com/labview/

https://www.ximea.com/support/wiki/vision-libraries/National\_Instruments\_LabVIEW

#### 5.3.1.4. OpenCV



OpenCV is an open source library of programming functions mainly aimed at real time computer vision, developed by Intel and now supported by Willow Garage.

More: https://opencv.org/

https://www.ximea.com/support/wiki/vision-libraries/OpenCV



# 5.4. XIMEA Windows Software Package

XIMEA API Software Package can be installed on: Microsoft Windows 10, Microsoft Windows 8, Microsoft Windows 7 (and Microsoft Windows 7 Embedded), Microsoft Windows 2008 R2.

#### 5.4.1. Contents

The package contains:

- OS Drivers of all XIMEA camera types for OS Microsoft Windows 7 SP1 32/64 bit, Windows 8 32/64 bit, Windows Server 2008 R2 x86-64, Windows 10 32/64 bit.
- APIs (xiAPI, xiAPI.NET, xiApiPython)
- Examples
- CamTool
- xiCop
- GenTL Producer for connection of GenTL Consumer applications.
- Vision Libraries integration demonstrations:
  - o NI LabView interface xiLib

#### 5.4.2. Installation

- Download and execute the XIMEA API Software Package installer (EXE-file, approx. 100 MB): http://www.ximea.com/downloads/recent/XIMEA\_Installer.exe
- Read the License Agreement.
- Start the installer

Be sure that you have administrator privileges or start the Installer with administrator rights (right click and select "run as administrator):

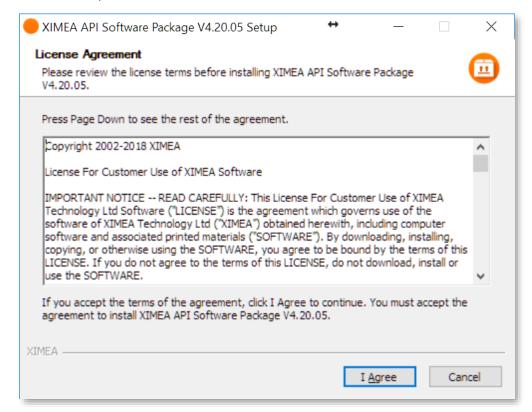


figure 5-2, XIMEA Windows Software Package installation - 1



• Select the Software components you want to install. You can uncheck the components you don't want to install, but it is recommended to leave them all checked.

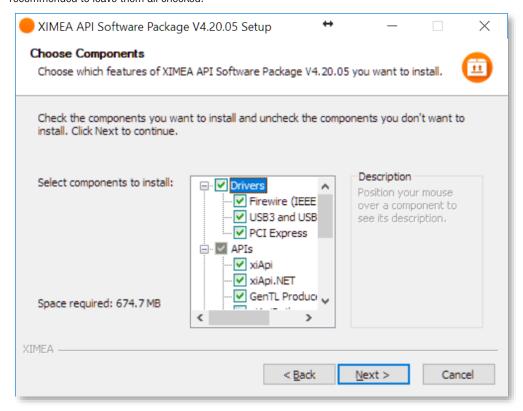


figure 5-3, XIMEA Windows Software Package installation - 2

• Specify the install location - you can leave the default location or change it to your desired location.

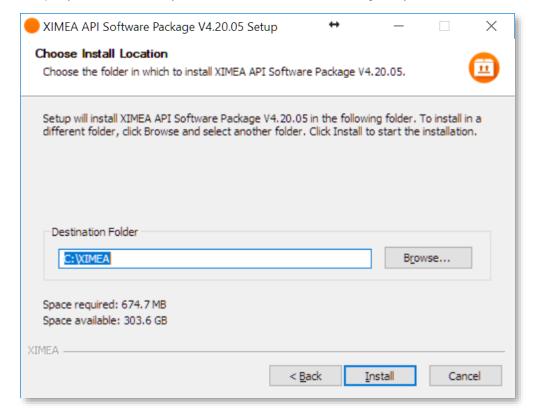


figure 5-4, XIMEA Windows Software Package installation - 3

 Now the XIMEA API Software Package should start copying files, updating System Variables and installing drivers if necessary.

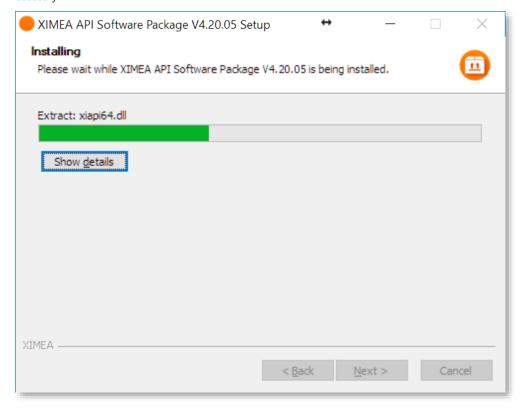


figure 5-5, xiAPI installation, Windows - 4

Installation is completed.

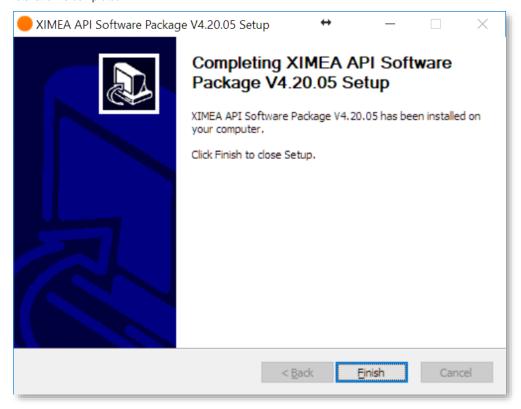


figure 5-6, xiAPI installation, Windows - 5

Finish.

# 5.5. XIMEA Linux Software Package

XIMEA Linux Software Package is tarred installer with files that can be run on Linux Ubuntu 14.04 and 16.04 (32 and 64 Bit) and newer releases.

#### 5.5.1. Contents

The package contains:

- Driver (beta version) for XIMEA USB2 and USB3 cameras
- xiAPI
- Ximea CamTool
- Examples:
  - o xiSample sample showing basic image acquisition in xiAPI

#### 5.5.2. Installation

Download XIMEA Linux Software Package
 wget http://www.ximea.com/downloads/recent/XIMEA\_Linux\_SP.tgz

figure 5-7, XIMEA Linux Software Package installation - 1

 Untar tar xzf XIMEA\_Linux\_SP.tgz cd package

- Start installation script
  - ./install

```
ximea@ximea-Linux64: ~/package
ximea@ximea-Linux64:~$ tar xzf XIMEA_Linux_SP.tgz
ximea@ximea-Linux64:~$ cd package
ximea@ximea-Linux64:~/package$ ./install -cam_usb30
This will install XIMEA Linux Package after 5 seconds
To abort installation - press Ctrl-C
Instaling x64 bit version
[sudo] password for ximea:
This is installation of package for platform -x64
Checking if user is super user
ΟK
WARNING!!!
You have enabled experimental USB3 support! It may affect USB2 support too.
DO NOT downgrade the kernel to versions older than 3.4!!!
Advised way of enabling USB3 support is upgrading kernel to version at least as new as 3.6.
If you decide to do it in the future, rerun this installation script after rebooting into new ke
rnel.
Installing libusb
Installing Firewire support - libraw1394
Checking Firewire stack
Installing API library
OK
OK
ок
Rebuilding linker cache
Installing XIMEA-GenTL library
Installing vaViewer
Installing streamViewer
Installing xiSample
Creating desktop link for vaViewer
Creating desktop link for streamViewer
Installing udev rules for USB and Firewire cameras
ок
Note:
You may need to reconnect your USB and/or Firewire cameras
Also check that you are in the "plugdev" group
More info:
http://www.ximea.com/support/wiki/apis/Linux_USB20_Support
For GeniCam - please add GENICAM_GENTL64_PATH=/opt/XIMEA/lib/libXIMEA_GenTL.so to Your .bashrc
o enable GenTL
Now applications can be started. E.g. /opt/XIMEA/bin/xiSample
Done OK
ximea@ximea-Linux64:~/package$
```

figure 5-8, XIMEA Linux Software Package installation - 2

1) **Note:** If logged in user is not root, you will be asked for your password to get root access, because the installation runs with root account using *sudo*.



## 5.6. XIMEA macOS Software Package

XIMEA macOS Software Package is native DMG installer that can be run on macOS 10.8 (Mountain Lion) or newer.

### 5.6.1. Contents

The package contains:

- Driver (beta version) for XIMEA USB2 and USB3 cameras
- xiAPI
- XIMEA CamTool
- Examples:
  - o xiSample sample showing basic image acquisition in xiAPI

#### 5.6.2. Installation

Before installing XIMEA macOS Software Package it may be necessary to modify security settings on your computer. The new feature of OS X 10.8 called GateKeeper can prevent you from using our macOS Software Package due to the fact that the current version is unsigned.

Open System Preferences application and click on Security & Privacy.



figure 5-9, XIMEA macOS Software Package installation - 1



On the General Tab select the option Anywhere under Allow applications downloaded from:



figure 5-10, xiAPI installation, MacOS - 2

- Download XIMEA macOS Software. Package: http://www.ximea.com/downloads/recent/XIMEA\_OSX\_SP.dmg
- Mount it by double-clicking this file in Finder.
- Run the install script to install XiAPI on your macOS system
- A window with package contents will open.

#### 5.6.3. Start XIMEA CamTool

- Connect camera
- Start Applications / XIMEA CamTool
- Start acquisition by clicking on orange triangle at upper left corner of CamTool

#### 5.7. Programming

### 5.7.1. XIMEA APIs

- xiAPI Streamlined API. The standard API for C/C++ based projects, see <u>5.7.2 xiAPI Overview</u>.
- xiAPI.NET Managed .NET Common Language Runtime (CLR) API.
   xiAPI.NET is designed as a wrapper around xiAPI and therefore shares most of its functionality.
- xiApiPython Integrated API into PYTHON.

#### 5.7.2. xiAPI Overview

xiAPI stands for XIMEA Application Programming Interface. It is a common interface for all XIMEA cameras.

#### Architecture

API is a software interface between the camera system driver and application.

- On Windows: xiAPI is compiled into xiapi32.dll or xiapi64.dll
- On Linux: xiAPI is compiled into /usr/lib/libm3api.so

#### Installation

xiAPI is part of all current XIMEA software packages for Windows, Linux and MacOS.

For information on the software packages, see 5 Software

#### 5.7.3. xiAPI Functions Description

The core of xiAPI consists of the following functions, which allow controlling of the camera functionality.

```
// get the number of discovered devices.
XI RETURN xiGetNumberDevices (OUT DWORD *pNumberDevices);
// open interface
XI RETURN xiOpenDevice(IN DWORD DevId, OUT PHANDLE hDevice);
// get parameter
XI RETURN xiGetParam(IN HANDLE hDevice, const char* prm, void* val,
DWORD * size, XI PRM TYPE * type);
// set parameter
XI RETURN xiSetParam(IN HANDLE hDevice, const char* prm, void* val,
DWORD size, XI PRM TYPE type);
// start the data acquisition
XI RETURN xiStartAcquisition(IN HANDLE hDevice);
// acquire image and return image information
XI RETURN xiGetImage(IN HANDLE hDevice, IN DWORD TimeOut, INOUT XI IMG
* img);
// stop the data acquisition
XI RETURN xiStopAcquisition(IN HANDLE hDevice);
// close interface
XI RETURN xiCloseDevice(IN HANDLE hDevice);
```

#### 5.7.4. xiAPI Parameters Description

For a complete list of available parameter, please visit the xiAPI online manual at <a href="http://www.ximea.com/support/wiki/apis/XiAPI\_Manual">http://www.ximea.com/support/wiki/apis/XiAPI\_Manual</a>

**Note:** Since xiAPI is a unified programming interface for all of XIMEA's cameras, not all of the described parameters apply for every camera and sensor model.

All functions in xiAPI return status values in form of the XI\_RETURN structure which is defined in xiApi.h. If a parameter is not supported by a certain camera, the return value will represent a respective error code (e.g. 106 - Parameter not supported).

#### 5.7.5. xiAPI Examples

#### 5.7.5.1. Connect Device

This example shows the enumeration of available devices. If any device was found the first device (with index 0) is opened.

#### 5.7.5.2. Parameterize Device

This example shows how an exposure time is set. Next, the maximum possible downsampling rate is retrieved and the result is set as new downsampling rate.

```
// Setting "exposure" parameter (10ms)
int time_us = 10000;
xiSetParam(xiH, XI_PRM_EXPOSURE, &time_us, sizeof(time_us),
xiTypeInteger);

// Getting maxium possible downsampling rate
int dspl_max = 1;
xiGetParamInt(xiH, XI_PRM_DOWNSAMPLING XI_PRM_INFO_MAX, &dspl_max);

// Setting maxium possible downsampling rate
xiSetParamInt(xiH, XI_PRM_DOWNSAMPLING, dspl_max);
```

#### 5.7.5.3. Acquire Images

This example shows how the acquisition is started on the device with the handle xiH, ten images are acquired in a row and the acquisition is stopped.

```
xiStartAcquisition(xiH);
#define EXPECTED_IMAGES 10
for (int images=0;images < EXPECTED_IMAGES;images++)
{
    // getting image from camera
    xiGetImage(xiH, 5000, &image);
    printf("Image %d (%dx%d) received from camera\n", images,
        (int)image.width, (int)image.height);
}
xiStopAcquisition(xiH);</pre>
```

#### 5.7.5.4. Control Digital Input / Output (GPIO)

#### Hardware Trigger and Exposure Active output

In this setup each image is triggered by a Digital Input Trigger. After the image is triggered, it can be transferred using xiGetImage.

This setup ensures a low latency between the trigger signal and image Exposure start. This time should be less than 10µs.

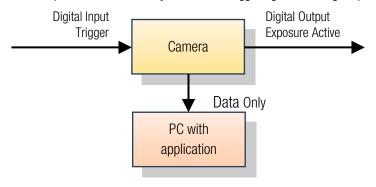


figure 5-11, GPIO - schematic

```
HANDLE xiH;
xiOpenDevice(0, & xiH);

// select trigger source
xiSetParamInt(xiH, XI_PRM_TRG_SOURCE, XI_TRG_EDGE_RISING);

// select input pin 1 mode
xiSetParamInt(xiH, XI_PRM_GPI_SELECTOR, 1);
xiSetParamInt(xiH, XI_PRM_GPI_MODE, XI_GPI_TRIGGER)

// set digital output 2 mode
xiSetParamInt(xiH, XI_PRM_GPO_SELECTOR, 2);
xiSetParamInt(xiH, XI_PRM_GPO_MODE, XI_GPO_EXPOSURE_ACTIVE);
xiStartAcquisition(handle1);

// Trigger signal should start image exposure within timeout
#define TIMEOUT_IMAGE_WAITING_MS 10000
xiGetImage(handle, TIMEOUT_IMAGE_WAITING_MS, &image);
// process image here...
```



#### 5.7.6. xiAPI Auto Bandwidth Calculation

xiAPI uses Auto Bandwidth Calculation (ABC) before the opening of each camera by default. After the measurement, 90% of the measured value is used as the maximum allowed transfer speed of the camera to ensure the stability of transfer.

It is important to set this parameter to XI\_OFF to ensure highest possible data transfer speed.

To disable ABC, the application should set parameter XI\_PRM\_AUTO\_BANDWIDTH\_CALCULATION to XI\_OFF before the first xiOpenDevice is used. This setting disabled ABC and the camera stream is not limited.

#### 5.7.7. GenlCam

For more information on programing according the GenlCam standard, please visit the standard's website at <a href="http://www.emva.org/standards-technology/genicam/">http://www.emva.org/standards-technology/genicam/</a>



#### 5.8. XIMEA Control Panel

The XIMEA Control Panel, or short xiCOP, is a diagnostics and management tool for all XIMEA cameras. xiCOP is currently only available for Windows operating system.

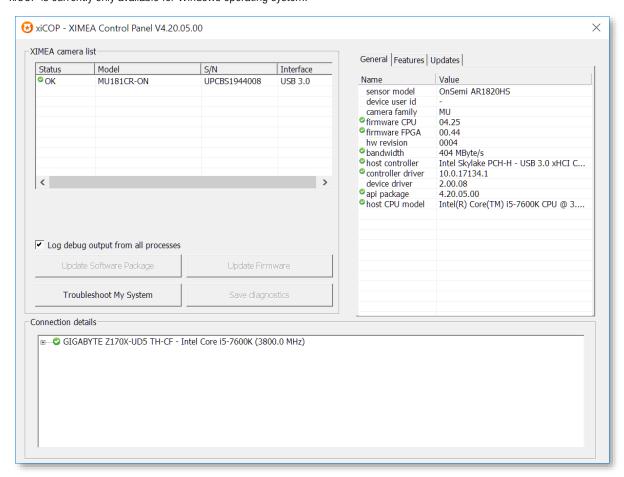


figure 5-12, xiCOP

#### Features

- Facilitates diagnostics of system performance bottlenecks.
  xiCOP is capable of retrieving the system's hardware tree, thus problematic hardware configurations can be identified.
- Diagnosis of firmware and software compatibility.
   xiCOP checks relevant firmware and software versions and warns is a component is not up-to-date.
- List all currently attached XIMEA devices and their features.
- Suggests solution for diagnosed issues.
- One click update to the latest XIMEA API Software Package.
- One click update of firmware in selected cameras. (not applicable for MU9)



## 6. Appendix

#### 6.1. Troubleshooting and Support

This chapter explains how to proceed, if you have issues in getting your xiMU camera to a proper operation. At first, please make sure, that you have installed the latest version of the following XIMEA software:

XIMEA API Software Package http://www.ximea.com/downloads/recent/XIMEA Installer.exe

Please make sure, that you have connected your xiMU camera with the XIMEA USB 2.0 cable to an appropriate USB 2.0 or USB 3.0 port. Ensure that the connections are carefully locked. Follow the instructions described in chapter <u>5.2 XIMEA CamTool</u> (run the xiMU camera with the Ximea CamTool). In case that you still have issues, please read the following chapters. If this does not at first work, please check all your connections to the camera and then try the latest 'beta' version of API with the most recent fixes: <a href="https://www.ximea.com/downloads/recent-beta/XIMEA">https://www.ximea.com/downloads/recent-beta/XIMEA</a> Installer.exe

In case that you still have issues, please read the following chapters.

#### 6.1.1. Worldwide Support

We offer worldwide first level support to you by our partners.

Please refer to your local dealer if you need technical support for your xiMU camera.

#### 6.1.2. Before Contacting Technical Support

There are a few steps to take before contacting your local dealer for technical support. In case you cannot display images from your xiMU camera, please open the XIMEA xiCOP software (please see <u>5.8 XIMEA Control Panel</u>). It will immediately start searching for connected cameras. Your camera will appear in the XIMEA camera list on the upper left side of the xiCOP window if it is connected properly and your USB interface meets the minimum system requirements described in <u>4.1 System Requirements</u>. If the camera does not appear, please proceed with the following steps:

Step no:	Description
1	Click on the button "Troubleshoot My System" and follow the instructions that are suggested.
2	If step 1 does not lead to a positive result, please click the button "Save diagnostics". Keep the diagnostic file ready for providing it to support.
3	Contact your local dealer where you bought the camera either by phone or by email for first level support. He will decide if he can help you immediately or if more information is necessary for initiating the next steps.

table 6-1, use xiCOP before contacting technical support

#### 6.1.3. Frequently Asked Questions

In this manual, we can list only a few FAQ. For more and updated information, please also note:

- Frequently Asked Questions
   http://www.ximea.com/support/wiki/allprod/Frequently\_Asked\_Questions
- Knowledge Base http://www.ximea.com/support/wiki/allprod/Knowledge\_Base

#### 6.2. Product service request (PSR)

If you experienced any unexpected behavior of your xiMU camera, please follow the steps described below:

#### 6.2.1. Step 1 - Contact Support

If your xiMU camera is not working as expected, please contact your local dealer for troubleshooting the product and determine the eligibility of a Product Service Request (PSR).

In case you were asked to create a PSR by your local contact, please continue to STEP 2

NOTE: Your product must be UNDER WARRANTY in order to qualify for a free repair or replacement.

#### 6.2.2. Step 2 - Create Product Service Request (PSR)

- Read the XIMEA General Terms & Conditions http://www.ximea.com/en/corporate/generaltc
- Open the XIMEA Product Service Request form http://www.ximea.com/support/projects/service/issues/new
- Fill in all fields
- Confirm with the button "Create"

#### 6.2.3. Step 3 - Wait for PSR Approval

Our support personnel will verify the PSR for validity.

If your PSR is valid, it will be approved for sending the camera to us. This is done usually within 24 business hours. After that you will get a PSR Approval email (sent to the email address that you have entered in the field "Contact person – email").

The email contains:

- shipping instructions
- attached document containing the Product Service Request Number (PSRN)

When you received the PSR Approval email - please continue to Step 4.

In case your PSR was rejected – please do not send your camera to XIMEA.

#### 6.2.4. Step 4 - Sending the camera to XIMEA

If possible, send the camera back in the original package. If not possible, please pack the camera in a way that it cannot be damaged during shipment and send it back as described in the PSR Approval email that you have received.

#### 6.2.5. Step 5 - Waiting for Service Conclusion

Once we have received the camera, we will send you a notification. The XIMEA Service will then check the status of the camera that you have sent for a possible repair. Depending on warranty conditions, product status and agreement one of the following operations will be performed:

Operation	Repair costs paid by	Return delivery costs paid by
repaired in warranty	XIMEA	XIMEA
replaced in warranty	XIMEA	XIMEA
repaired for cost	Customer	Customer
not repaired and returned	-	Customer
not repaired and discarded if requested by customer	-	-

table 6-2, service operations overview

If the camera will be returned, you will receive the tracking number. In this case, please continue to step 6

## 6.2.6. Step 6 - Waiting for return delivery

After you have received the return shipment, please confirm it by changing the status of the PSR to "Received by customer".



## 6.3. Safety instructions and precautions

Safety instructions and precautions are available at the following XIMEA webpage: Safety instructions and precautions.

## 6.4. Warranty

Information about warranty is available at the following XIMEA webpage: Warranty.

#### 6.5. List Of Trademarks

List of Trademarks is available at the following XIMEA webpage: List of Trademarks.

#### 6.6. Standard Terms & Conditions of XIMEA GmbH

The Standard Terms and Conditions are available at the following XIMEA webpage: General Terms and Conditions.

## 6.7. Copyright

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## 6.8. Revision History

Version	Date	Notes
1.00	07/26/2013	Initial version
1.20	05/05/2015	Corrected wrong information, added IO signaling
1.21	10/10/2015	Minor changes in specification
1.22	12/01/2016	Corrected typos
1.23	01/25/2017	Corrected typos
1.24	03/28/2017	Updated specification
1.25	04/18/2017	Software chapter review
1.26	08/31/2017	Added chapter 3.5 Heat Dissipation
1.27	08/21/2018	Added accessories ADPT-MU9P-USB2-UB-V
1.28	09/06/2019	IO naming changed (removed RX/TX names) - UART is not supported Corrected operating conditions.
2.01	08/13/2020	Added USB3.1 Gen1 camera family
2.10	06/02/2021	Corrected: MU9 scope of delivery. Chapter 6.7 (T&C) Replaced with latest version
		Part-number MU9 lens adapters corrected
2.11	10/27/2023	Corrected USB3.1 resolution



# 7. Glossary

Term /Abbreviation	Definition
ADC	Analog to Digital Converter
API	Application Programming Interface
AR (coating)	Anti-Reflex
B/W or B&W	Black and White
CCD	Charge-Coupled Device
CDS	Correlated double sampling
CMOS	Complementary Metal Oxide Semiconductor
DNC	Do not connect
DSNU	Dark Signal non-Uniformity
DR	Dynamic Range
EMC	Electro Magnetic Compatibility
ERS	Electronic rolling shutter
FPN	Fixed pattern noise
FPS	Frame per second
FWC	Full Well Capacity
GR	Global reset
GS	Global shutter
IR	Infra-Red
JTAG	Joint Test Action Group
LSB	Least Significant Bit
MIMR	Multiple integration multiple ROI
MSB	Most significant bit
MSL	Moisture sensitivity level
NA	Not Available
PCB	Printed Circuit Board (same as PWB)
PGA	Programmable gain amplifier
PRNU	Photo response non-uniformity
PWB	Printed Wiring Board (same as PCB)
RGB	Red Green Blue
ROI	Region of interest
Sat	Saturation value
SDK	Software Development Kit
SIMR	Single integration multiple ROI
SNR	Signal To Noise (ratio)
SPI	Serial peripheral interface
SW	Software
Tint	Integration time



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